

# NCN49597

## Power Line Communication Modem

The NCN49597 is a powerful spread frequency shift keying (S-FSK) communication system-on-chip (SoC) designed for communication in hostile environments.

It combines a low power ARM Cortex M0 processor with a high precision analogue front end. Based on 4800 baud S-FSK dual-channel technology, it offers an ideal compromise between speed and robustness.

Pin-compatible with its predecessor, the AMIS-49587, this new generation chip extends the communication frequency range to cover all CENELEC bands for use in applications such as e-metering, home automation and street lighting. The NCN49597 benefits for more than 10 years of field experience in e-metering and delivers innovative features such as a smart synchronization and in-band statistics.

Fully reprogrammable, the modem firmware can be updated in the field. Multiple royalty-free firmware options are available from ON Semiconductor; refer to the separate datasheets for details. The configurable GPIOs allow connecting peripherals such as LCDs or metering ICs.

### Features

- Power Line Communication (PLC) Modem for 50 Hz, 60 Hz and DC Mains
- Embedded ARM Cortex M0 Processor
- 10 General Purpose IOs Controllable by Software
- Embedded 32 kB RAM
- Embedded 2 kB ROM Containing Boot Loader
- Hardware Compliant with CENELEC EN 50065-1 and EN 50065-7 Half Duplex S-FSK Channel, Data Rate Selectable:
  - 300 – 600 – 1200 – 2400 – 4800 baud (@ 50 Hz);
  - 360 – 720 – 1440 – 2880 – 5760 baud (@ 60 Hz)
- Programmable Carrier Frequencies in CENELEC A, B, C and D Band
- UART for Interfacing with an Application Microcontroller
- Power Supply 3.3 V
- Wide Junction Temperature Range: -40°C to +125°C

### Available Firmware Options

- ON-PL110 – Mesh Networking with Collision Avoidance and Error Correction
- Complete Handling of Protocol Layers (physical, MAC, LLC)

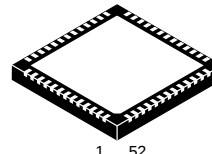
### Typical Applications

- AMR: Remote Automated Meter Reading
- Building Automation
- Solar Power Control and Monitoring
- Street Light Control and Monitoring
- Transmission of Alerts (fire, gas leak, water leak)



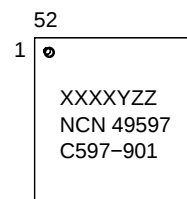
**ON Semiconductor®**

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QFN52 8x8, 0.5P  
CASE 485M

### MARKING DIAGRAM



XXXX = Date Code  
Y = Plant Identifier  
ZZ = Traceability Code

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 29 of this data sheet.

### Figure 1. Typical Application for the NCN49597 S-FSK Modem

In the receive path a 2<sup>nd</sup> order high pass filter blocks the mains frequency. The corner point – defined by  $C_1$ ,  $C_2$ ,  $R_1$  and  $R_2$  – is designed at 10 kHz. In the transmit path a 3<sup>th</sup>

Table 1. EXTERNAL COMPONENTS LIST AND DESCRIPTION

| Component                                                           | Function and Remarks                                                    | Value        | Tolerance | Unit |
|---------------------------------------------------------------------|-------------------------------------------------------------------------|--------------|-----------|------|
| C <sub>1</sub> , C <sub>2</sub>                                     | High pass receive filter                                                | 1.5          | ±10%      | nF   |
| C <sub>5</sub> , C <sub>DREF</sub>                                  | V <sub>COM</sub> & V <sub>REF_OUT</sub> ceramic decoupling              | 1            | -20 +80%  | μF   |
| C <sub>7</sub> , C <sub>9</sub> , C <sub>16</sub> , C <sub>17</sub> | Supply decoupling                                                       | 100          | -20 +80%  | nF   |
| C <sub>3</sub>                                                      | TX_OUT signal coupling                                                  | 470          | ±20%      | nF   |
| C <sub>4</sub>                                                      | Low pass transmit filter                                                | 470          | ±10%      | pF   |
| C <sub>6</sub>                                                      | Low pass transmit filter                                                | 68           | ±10%      | pF   |
| C <sub>8</sub>                                                      | Low pass transmit filter                                                | 3            | ±10%      | pF   |
| C <sub>10</sub>                                                     | Transmission signal coupling cap;<br>1 A <sub>RMS</sub> ripple @ 70 kHz | 10           | ±20%      | μF   |
| C <sub>11</sub>                                                     | High voltage coupling; 630 VDC                                          | 220          | ±20%      | nF   |
| C <sub>12</sub>                                                     | Zero crossing noise suppression                                         | 100          | ±20%      | pF   |
| C <sub>13</sub> , C <sub>14</sub>                                   | Crystal load capacitor                                                  | 22           | ±20%      | pF   |
| C <sub>15</sub>                                                     | Internal 1.8 V supply decoupling; ceramic                               | 1            | -20 +80%  | μF   |
| R <sub>1</sub>                                                      | High pass receive filter                                                | 22           | ±1%       | kΩ   |
| R <sub>2</sub>                                                      | High pass receive filter                                                | 11           | ±1%       | kΩ   |
| R <sub>3</sub>                                                      | High pass receive filter                                                | 10           | ±1%       | kΩ   |
| R <sub>9</sub>                                                      | Line driver current limitation setting                                  | 10           | ±1%       | kΩ   |
| R <sub>4</sub>                                                      | Low pass transmit filter                                                | 3.3          | ±1%       | kΩ   |
| R <sub>5</sub>                                                      | Low pass transmit filter                                                | 10           | ±1%       | kΩ   |
| R <sub>6</sub>                                                      | Low pass transmit filter                                                | 8.2          | ±1%       | kΩ   |
| R <sub>7</sub>                                                      | Low pass transmit filter                                                | 500          | ±1%       | Ω    |
| R <sub>8</sub>                                                      | Low pass transmit filter                                                | 3            | ±1%       | kΩ   |
| R <sub>10</sub>                                                     | Line transients protection; 0.5 W                                       | 0.47         | ±10%      | Ω    |
| R <sub>11</sub>                                                     | Zero crossing coupling                                                  | 1            | ±10%      | MΩ   |
| R <sub>12</sub> , R <sub>13</sub>                                   | Pull up                                                                 | 10           | ±10%      | kΩ   |
| D <sub>1</sub> , D <sub>2</sub>                                     | High-current Schottky clamp diodes                                      | MBRA340      |           |      |
| D <sub>3</sub> , D <sub>4</sub>                                     | Unidirectional TVS                                                      | P6SMB6.8AT3G |           |      |
| D <sub>5</sub>                                                      | Dual low-current Schottky clamp diode                                   | BAS70-04     |           |      |
| Y1                                                                  | Crystal                                                                 | 48 MHz       | 50 ppm    |      |
| Tr                                                                  | 2:1 signal transformer                                                  |              |           |      |
| U1                                                                  | PLC modem                                                               | NCN49597     |           |      |
| U2                                                                  | Power operational amplifier                                             | NCS5651      |           |      |

**Table 2. ABSOLUTE MAXIMUM RATINGS**

| Rating                                                                                            | Symbol                   | Min             | Max              | Unit |
|---------------------------------------------------------------------------------------------------|--------------------------|-----------------|------------------|------|
| <b>POWER SUPPLY PINS VDD, VDDA, VSS, VSSA</b>                                                     |                          |                 |                  |      |
| Absolute max. digital power supply                                                                | $V_{DD\_ABSM}$           | $V_{SS} - 0.3$  | 3.9              | V    |
| Absolute max. analog power supply                                                                 | $V_{DDA\_ABSM}$          | $V_{SSA} - 0.3$ | 3.9              | V    |
| Absolute max. difference between digital and analog power supply                                  | $V_{DD} - V_{DDA\_ABSM}$ | -0.1            | 0.1              | V    |
| Absolute max. difference between digital and analog ground                                        | $V_{SS} - V_{SSA\_ABSM}$ | -0.1            | 0.1              | V    |
| <b>CLOCK PINS XIN, XOUT</b>                                                                       |                          |                 |                  |      |
| Absolute maximum input for the clock input pin (Note 1)                                           | $V_{XIN\_ABSM18}$        | $V_{SS} - 0.2$  | $V_{DD18} + 0.2$ | V    |
| Absolute maximum voltage at the clock output pin (Note 1)                                         | $V_{XOUT\_ABSM18}$       | $V_{SS} - 0.2$  | $V_{DD18} + 0.2$ | V    |
| <b>NON 5 V SAFE PINS: TX_OUT, ALC_IN, RX_IN, RX_OUT, REF_OUT, ZC_IN, TDO, SCK, SDO, SCB</b>       |                          |                 |                  |      |
| Absolute maximum input for normal digital inputs and analog inputs                                | $V_{N5VSIN\_ABSM}$       | $V_{SS} - 0.3$  | $V_{DD} + 0.3$   | V    |
| Absolute maximum voltage at any output pin                                                        | $V_{N5VSOUT\_ABSM}$      | $V_{SS} - 0.3$  | $V_{DD} + 0.3$   | V    |
| Maximum peak input current at the zerocrossing input pin                                          | $I_{mpZC\_IN}$           | -20             | 20               | mA   |
| Maximum average input current at the zerocrossing input pin (1 ms)                                | $I_{avgZC\_IN}$          | -2              | 2                | mA   |
| <b>5 V SAFE PINS: TX_ENB, TXD, RXD, BR0, BR1, IO0..IO9, RESB, TDI, TCK, TMS, TRSTB, TEST, SDI</b> |                          |                 |                  |      |
| Absolute maximum input for digital 5 V safe pins configured as input (Note 2)                     | $V_{5VSIN\_ABSM}$        | $V_{SS} - 0.3$  | 5.5              | V    |
| Absolute maximum voltage at 5 V safe pin configured as output (Note 2)                            | $V_{5VSOUT\_ABSM}$       | $V_{SS} - 0.3$  | $V_{DD} + 0.3$   | V    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The upper maximum voltage rating on the clock pins XIN and XOUT is specified with respect to the output voltage of the internal core voltage regulator. The tolerance of this voltage regulator must be taken into account. In case an external clock is used, care must be taken not to damage the XIN pin.
2. The direction (input or output) of configurable pins (IO0...IO9) depends on the firmware.

### Normal Operating Conditions

Operating ranges define the limits for functional operation and parametric characteristics of the device as described in the Electrical Characteristics section and for the reliability specifications.

Total cumulative dwell time outside the normal power supply voltage range or the ambient temperature under bias, must be less than 0.1 percent of the useful life.

**Table 3. OPERATING RANGES**

| Rating                                         | Symbol            | Min | Max | Unit |
|------------------------------------------------|-------------------|-----|-----|------|
| Power supply voltage range (VDDA and VDD pins) | $V_{DD}, V_{DDA}$ | 3.0 | 3.6 | V    |
| Junction Temperature Range                     | $T_J$             | -40 | 125 | °C   |
| Ambient Temperature Range                      | $T_A$             | -40 | 115 | °C   |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# NCN49597

## PIN DESCRIPTION – QFN Package

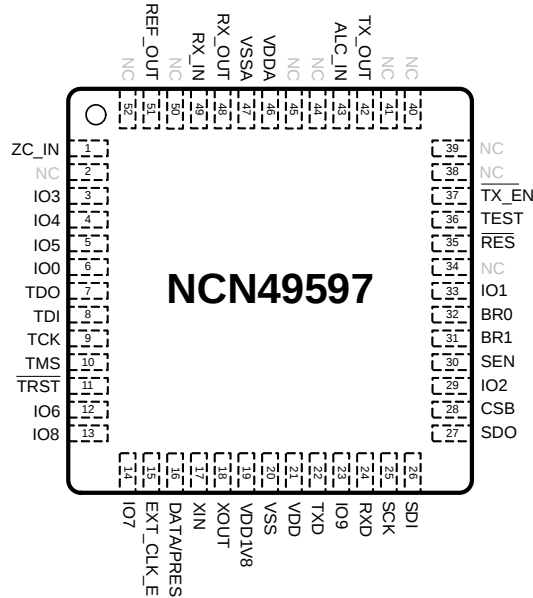


Figure 2. QFN Pin-out of NCN49597 (top view)

Table 4. NCN49597 QFN PIN FUNCTION DESCRIPTION

| Pin Number   | Pin Name  | I/O    | Type           | Description                                                                                      |
|--------------|-----------|--------|----------------|--------------------------------------------------------------------------------------------------|
| 1            | ZC_IN     | In     | A              | 50/60 Hz input for mains zero crossing detection                                                 |
| 3..5, 12..14 | IO3..IO7  | In/Out | D, 5VS, ST     | General purpose I/O's (Note 3)                                                                   |
| 6, 33        | IO0, IO1  | In/Out | D, 5VS, ST     | General purpose I/O's (Notes 3 and 4)                                                            |
| 13, 23       | IO8, IO9  | In/Out | D, 5VS, ST, PD | General purpose IO (Notes 3 and 9)                                                               |
| 7            | TDO       | Out    | D              | JTAG test data output                                                                            |
| 8            | TDI       | In     | D, 5VS, PD, ST | JTAG test data input (Note 7)                                                                    |
| 9            | TCK       | In     | D, 5VS, PD     | JTAG test clock (Note 7)                                                                         |
| 10           | TMS       | In     | D, 5VS, PD     | JTAG test mode select (Note 7)                                                                   |
| 11           | TRSTB     | In     | D, 5VS, PD, ST | JTAG test reset (active low) (Note 8)                                                            |
| 15           | EXT_CLK_E | In     | D, 5VS, PD, ST | External clock enable input                                                                      |
| 16           | DATA/PRES | Out    | D, 5VS, OD     | Output of transmitted data (DATA) or PRE_SLOT signal (PRES)                                      |
| 17           | XIN       | In     | A, 1.8 V       | Crystal oscillator input                                                                         |
| 18           | XOUT      | Out    | A, 1.8 V       | Crystal oscillator output (output must be left floating when XIN is driven by an external clock) |
| 19           | VDD1V8    |        | P              | 1.8 V regulator output. A decoupling capacitor of at least 1 $\mu$ F is required for stability   |
| 20           | VSS       |        | P              | Digital ground                                                                                   |
| 21           | VDD       |        | P              | 3.3 V digital supply                                                                             |

- The direction and function of the general-purpose I/O's is controlled by the firmware. Depending on the firmware behavior, a general-purpose IO (GPIO) used as an output may appear as an open-drain, push-pull or open-source pin. Refer to the firmware documentation for details.
- During boot (i.e., before firmware has been uploaded) this pin is an output and indicates the status of the boot loader. Once firmware has been loaded, the pin is available as a GPIO.
- During normal operation, this pin *must* be tied to ground (recommended) or left open.
- If the modem is not loading the firmware from an external SPI memory, it is recommended that this pin is tied to ground or Vdd.
- During normal operation, it is recommended that this pin is tied to ground.
- During normal operation, this pin must be tied to Vdd.
- If a general purpose IO is configured as an output, the pull-down resistor is disconnected.

Table 4. NCN49597 QFN PIN FUNCTION DESCRIPTION

| Pin Number                    | Pin Name | I/O    | Type           | Description                                                                                                         |
|-------------------------------|----------|--------|----------------|---------------------------------------------------------------------------------------------------------------------|
| 22                            | TXD      | Out    | D, 5VS, OD     | UART transmit output                                                                                                |
| 24                            | RXD      | In     | D, 5VS, ST     | UART receive input                                                                                                  |
| 25                            | SCK      | Out    | D, 5VS         | SPI interface to external Flash: clock                                                                              |
| 26                            | SDI      | In     | D, 5VS, ST     | SPI interface to external Flash: serial data input (Note 6)                                                         |
| 27                            | SDO      | Out    | D, 5VS         | SPI interface to external Flash: serial data output                                                                 |
| 28                            | CSB      | Out    | D, 5VS         | SPI interface to external Flash: chip select                                                                        |
| 29                            | IO2      | In/Out | D, 5VS, ST     | Must be kept low while firmware is loaded over the serial interface; available as a normal GPIO afterwards (Note 3) |
| 30                            | SEN      | In     | D, 5VS, PD, ST | Boot mode selection (refer to Boot Loader section)                                                                  |
| 31                            | BR1      | In     | D, 5VS         | UART baud rate selection                                                                                            |
| 32                            | BR0      | In     | D, 5VS         | UART baud rate selection                                                                                            |
| 35                            | RESB     | In     | D, 5VS, ST     | Reset (active low)                                                                                                  |
| 36                            | TEST     | In     | D, 5VS, PD, ST | Production hardware test enable (Note 5)                                                                            |
| 37                            | TX_ENB   | Out    | D, 5VS, OD     | Transmit enable (active low)                                                                                        |
| 42                            | TX_OUT   | Out    | A              | Transmitter output                                                                                                  |
| 43                            | ALC_IN   | In     | A              | Automatic level control input                                                                                       |
| 46                            | VDDA     |        | P              | 3.3 V analog supply                                                                                                 |
| 47                            | VSSA     |        | P              | Analog ground                                                                                                       |
| 48                            | RX_OUT   | Out    | A              | Output of receiver operational amplifier                                                                            |
| 49                            | RX_IN    | In     | A              | Non-inverting input of receiver operational amplifier                                                               |
| 51                            | REF_OUT  | Out    | A              | Internal voltage reference. A decoupling capacitor of at least 1 $\mu$ F is required for stability                  |
| 2, 34, 38, 41, 44, 45, 50, 52 | NC       |        |                | These pins are not connected and must be connected to ground (recommended) or left open                             |

- The direction and function of the general-purpose I/O's is controlled by the firmware. Depending on the firmware behavior, a general-purpose IO (GPIO) used as an output may appear as an open-drain, push-pull or open-source pin. Refer to the firmware documentation for details.
- During boot (i.e., before firmware has been uploaded) this pin is an output and indicates the status of the boot loader. Once firmware has been loaded, the pin is available as a GPIO.
- During normal operation, this pin *must* be tied to ground (recommended) or left open.
- If the modem is not loading the firmware from an external SPI memory, it is recommended that this pin is tied to ground or Vdd.
- During normal operation, it is recommended that this pin is tied to ground.
- During normal operation, this pin must be tied to Vdd.
- If a general purpose IO is configured as an output, the pull-down resistor is disconnected.

|     |                                      |       |                                                                                          |
|-----|--------------------------------------|-------|------------------------------------------------------------------------------------------|
| P:  | Power pin                            | 5VS:  | 5 V safe; pin that supports the presence of 5 V if used as input or as open-drain output |
| A:  | Analog pin                           | Out:  | Output signal                                                                            |
| D:  | Digital pin                          | In:   | Input signal                                                                             |
| PD: | Internal Pull Down resistor (Note 9) | ST:   | Schmitt trigger input.                                                                   |
| OD: | Open Drain Output                    | 1.8V: | The maximal voltage on this pin is 1.8 V                                                 |

**Table 5. ELECTRICAL CHARACTERISTICS**

All parameters are valid for  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ ,  $f_{CLK} = 48\text{ MHz} \pm 50\text{ ppm}$  unless otherwise specified.

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
|-----------|-----------------|--------|-----|-----|-----|------|
|-----------|-----------------|--------|-----|-----|-----|------|

**INTERNAL VOLTAGE REGULATOR: PIN VDD1V8 (power supply and voltage reference)**

|                                            |                               |             |      |      |      |    |
|--------------------------------------------|-------------------------------|-------------|------|------|------|----|
| $V_{DD}$ and $V_{DDA}$ current consumption |                               | $V_{DD18}$  | 1.62 | 1.80 | 1.98 | V  |
|                                            | During reception (Note 10)    | $I_{RX}$    |      | 40   | 60   | mA |
|                                            | During transmission (Note 10) | $I_{TX}$    |      | 40   | 60   | mA |
|                                            | RESB = 0                      | $I_{RESET}$ |      |      | 4    | mA |

**OSCILLATOR: PIN XIN, XOUT (Note 11)**

|                                    |                                         |                 |                   |   |                   |          |
|------------------------------------|-----------------------------------------|-----------------|-------------------|---|-------------------|----------|
| Duty cycle with quartz connected   |                                         |                 | 35                |   | 65                | %        |
| Start-up time                      |                                         | $T_{startup}$   |                   |   | 15                | ms       |
| Load capacitance external crystal  |                                         | $C_L$           |                   |   | 18                | pF       |
| Series resistance external crystal |                                         | $R_S$           | 1                 | 6 | 60                | $\Omega$ |
| Maximum Capacitive load on XOUT    | XIN used as clock input                 | $CL_{XOUT}$     |                   |   | 15                | pF       |
| Low input threshold voltage        | XIN used as clock input                 | $V_{IL_{XOUT}}$ | 0.3<br>$V_{DD18}$ |   |                   | V        |
| High input threshold voltage       | XIN used as clock input                 | $V_{IH_{XOUT}}$ |                   |   | 0.7<br>$V_{DD18}$ | V        |
| Low output voltage                 | XIN used as clock input,<br>XOUT = 2 mA | $V_{OL_{XOUT}}$ |                   |   | 0.3               | V        |
| High input voltage                 | XIN used as clock input                 | $V_{OH_{XOUT}}$ |                   |   | $V_{DD18} - 0.3$  | V        |
| Rise and fall time on XIN          | XIN used as clock input                 | $t_{XIN\_EXT}$  |                   |   | 1.5               | ns       |

**ZERO CROSSING DETECTOR AND 50/60 HZ PLL: PIN ZC\_IN**

|                                                         |                                                |                      |      |  |     |               |
|---------------------------------------------------------|------------------------------------------------|----------------------|------|--|-----|---------------|
| Mains voltage input range                               | With protection resistor at ZC_IN<br>(Note 12) | $V_{MAINS}$          | 90   |  | 550 | $V_{PK}$      |
| Rising threshold level                                  |                                                | $V_{IR_{ZC\_IN}}$    |      |  | 1.9 | V             |
| Falling threshold level                                 |                                                | $V_{IF_{ZC\_IN}}$    | 0.85 |  |     | V             |
| Hysteresis                                              |                                                | $V_{HY_{ZC\_IN}}$    | 0.4  |  |     | V             |
| Lock range (Note 13)                                    | $R\_CONF[0] = 0$ (50 Hz)                       | $F_{lock_{50Hz}}$    | 45   |  | 55  | Hz            |
|                                                         | $R\_CONF[0] = 1$ (60 Hz)                       | $F_{lock_{60Hz}}$    | 54   |  | 66  | Hz            |
| Lock time (Note 13)                                     | $R\_CONF[0] = 0$ (50 Hz)                       | $T_{lock_{50Hz}}$    |      |  | 15  | s             |
|                                                         | $R\_CONF[0] = 1$ (60 Hz)                       | $T_{lock_{60Hz}}$    |      |  | 20  | s             |
| Frequency variation without going out of lock (Note 13) | $R\_CONF[0] = 0$ (50 Hz)                       | $DF_{60Hz}$          |      |  | 0.1 | Hz/s          |
| Frequency variation without going out of lock (Note 13) | $R\_CONF[0] = 1$ (60 Hz)                       | $DF_{50Hz}$          |      |  | 0.1 | Hz/s          |
| Jitter of CHIP_CLK (Note 13)                            |                                                | $Jitter_{CHIP\_CLK}$ |      |  | 25  | $\mu\text{s}$ |

10. With typical firmware. The exact value depends on the firmware variant loaded and the firmware configuration.

11. In production the actual oscillation of the oscillator and duty cycle will not be tested. The production test will be based on the static parameters and the inversion from XIN to XOUT in order to guarantee the functionality of the oscillator.

12. This parameter is not tested in production.

13. These parameters will not be measured in production as the performance is determined by a digital circuit. Correct operation of this circuit will be guaranteed by the digital test patterns.

**Table 5. ELECTRICAL CHARACTERISTICS**All parameters are valid for  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ ,  $f_{CLK} = 48\text{ MHz} \pm 50\text{ ppm}$  unless otherwise specified.

| Parameter                                                          | Test Conditions                                                                                                                                                   | Symbol                                                                                                                                                                       | Min                  | Typ        | Max                             | Unit       |
|--------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|------------|---------------------------------|------------|
| <b>TRANSMITTER EXTERNAL PARAMETERS: PIN TX_OUT, ALC_IN, TX_ENB</b> |                                                                                                                                                                   |                                                                                                                                                                              |                      |            |                                 |            |
| AC output level                                                    | $f_{TX\_OUT} = 23 - 75\text{ kHz}$ (Note 14)<br>$f_{TX\_OUT} = 148.5\text{ kHz}$ (Note 14)                                                                        | $V_{TX\_OUT}$                                                                                                                                                                | 0.85<br>0.76         |            | 1.15<br>1.22                    | $V_{PK}$   |
| DC output level                                                    |                                                                                                                                                                   | $V_{TX\_OUT}$                                                                                                                                                                |                      | 1.65       |                                 | V          |
| Second order harmonic distortion                                   | $f_{TX\_OUT} = 148.5\text{ kHz}$ (Note 14)                                                                                                                        | HD2                                                                                                                                                                          |                      |            | -55                             | dB         |
| Third order harmonic distortion                                    | $f_{TX\_OUT} = 148.5\text{ kHz}$ (Note 14)                                                                                                                        | HD3                                                                                                                                                                          |                      |            | -57                             | dB         |
| Transmitted carrier frequency resolution                           |                                                                                                                                                                   | $R_{fTX\_OUT}$                                                                                                                                                               | 11.44                |            | 11.44                           | Hz         |
| Transmitted carrier frequency accuracy                             | (Note 15)                                                                                                                                                         | $D_{fTX\_OUT}$                                                                                                                                                               |                      |            | 30                              | Hz         |
| Capacitive output load at pin TX_OUT                               | (Note 15)                                                                                                                                                         | $CL_{TX\_OUT}$                                                                                                                                                               |                      |            | 20                              | pF         |
| Resistive output load at pin TX_OUT                                |                                                                                                                                                                   | $RL_{TX\_OUT}$                                                                                                                                                               | 5                    |            | 5                               | k $\Omega$ |
| Turn off delay of TX_ENB output                                    |                                                                                                                                                                   | $T_{dTX\_ENB}$                                                                                                                                                               | 0.25                 |            | 0.5                             | ms         |
| Automatic level control attenuation step                           |                                                                                                                                                                   | $ALC_{step}$                                                                                                                                                                 | 2.9                  |            | 3.1                             | dB         |
| Maximum attenuation                                                |                                                                                                                                                                   | $ALC_{range}$                                                                                                                                                                | 20.3                 |            | 21.7                            | dB         |
| Low threshold level on ALC_IN                                      | With DC bias equal to $V_{REF\_OUT}$                                                                                                                              | $V_{TL\_ALC\_IN}$                                                                                                                                                            | 0.34                 |            | 0.46                            | $V_{PK}$   |
| High threshold level on ALC_IN                                     | With DC bias equal to $V_{REF\_OUT}$                                                                                                                              | $V_{TH\_ALC\_IN}$                                                                                                                                                            | 0.54                 |            | 0.72                            | $V_{PK}$   |
| Input impedance of ALC_IN pin                                      |                                                                                                                                                                   | $R_{ALC\_IN}$                                                                                                                                                                | 111                  |            | 189                             | k $\Omega$ |
| Power supply rejection ratio of the transmitter section            | $f = 50\text{ Hz}$ (Note 16)<br>$f = 10\text{ kHz}$ (Note 16)                                                                                                     | $PSRR_{TX\_OUT}$                                                                                                                                                             | 32<br>10             |            |                                 | dB         |
| Transmit cascade gain (Note 17)                                    | $f = 10\text{ kHz}$<br>$f = 148.5\text{ kHz}$<br>$f = 195\text{ kHz}$<br>$f = 245\text{ kHz}$<br>$f = 500\text{ kHz}$<br>$f = 1\text{ MHz}$<br>$f = 2\text{ MHz}$ | $V_{TX\_PF\_10kHz}$<br>$V_{TX\_LPF\_148kHz5}$<br>$V_{TX\_LPF\_195kHz}$<br>$V_{TX\_LPF\_245kHz}$<br>$V_{TX\_LPF\_500kHz}$<br>$V_{TX\_LPF\_1000kHz}$<br>$V_{TX\_LPF\_2000kHz}$ | -0.5<br>-1.3<br>-4.5 |            | 0.5<br>0.5<br>-1.5<br>-3<br>-18 | dB         |
|                                                                    |                                                                                                                                                                   |                                                                                                                                                                              |                      | -36<br>-50 |                                 |            |

14. With the level control register set for maximal output amplitude. Tested with low pass filter tuned for CENELEC D-band.

15. This parameter will not be tested in production.

16. A sinusoidal signal of 100 mVpp is injected between VDDA and VSSA while the digital AD converter generates an idle pattern. The signal level at TX\_OUT is measured to determine the parameter.

17. The cascade of the digital-to-analog converter (DAC), low-pass filter (LPF), and transmission amplifier is production tested and must have a frequency characteristic between the limits listed. The level is specified relative to the level at DC; the absolute output level will depend on the operating condition.

This test is done with the low-pass filter (LPF) tuned to include the CENELEC D-band. In production the measurement will be done for relative to DC with a signal amplitude of 100 mV.

**Table 5. ELECTRICAL CHARACTERISTICS**All parameters are valid for  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ ,  $f_{CLK} = 48\text{ MHz} \pm 50\text{ ppm}$  unless otherwise specified.

| Parameter                                                              | Test Conditions                                                                                                                                                          | Symbol                                                                                                                                                                         | Min                  | Typ                 | Max                           | Unit                         |
|------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|---------------------|-------------------------------|------------------------------|
| <b>RECEIVER EXTERNAL PARAMETERS: PIN RX_IN, RX_OUT, REF_OUT</b>        |                                                                                                                                                                          |                                                                                                                                                                                |                      |                     |                               |                              |
| Input offset voltage                                                   | AGC gain = 42 dB                                                                                                                                                         | $V_{OFFS\_RX\_IN}$                                                                                                                                                             |                      |                     | 5                             | mV                           |
|                                                                        | AGC gain = 0 dB                                                                                                                                                          | $V_{OFFS\_RX\_IN}$                                                                                                                                                             |                      |                     | 50                            | mV                           |
| Max. peak input voltage (corresponding to 62.5% of the ADC full scale) | AGC gain = 0 dB (Note 18)                                                                                                                                                | $V_{MAX\_RX\_IN}$                                                                                                                                                              | 0.85                 |                     | 1.15                          | $V_{PK}$                     |
| Input referred noise of the analog receiver path                       | AGC gain = 42 dB (Notes 18 and 19)                                                                                                                                       | $NF_{RX\_IN}$                                                                                                                                                                  |                      |                     | 150                           | $\text{nV}/\sqrt{\text{Hz}}$ |
| Input leakage current of receiver input                                |                                                                                                                                                                          | $I_{LE\_RX\_IN}$                                                                                                                                                               | -1                   |                     | 1                             | $\mu\text{A}$                |
| Max. current delivered by REF_OUT                                      |                                                                                                                                                                          | $I_{Max\_REF\_OUT}$                                                                                                                                                            | -300                 |                     | 300                           | $\mu\text{A}$                |
| Power supply rejection ratio of the receiver input section             | f = 50 Hz (Note 20)                                                                                                                                                      | $PSRR_{LPF\_OUT}$                                                                                                                                                              | 35                   |                     |                               | dB                           |
|                                                                        | f = 10 kHz (Note 20)                                                                                                                                                     |                                                                                                                                                                                | 10                   |                     |                               | dB                           |
| AGC gain step                                                          |                                                                                                                                                                          | $AGC_{step}$                                                                                                                                                                   | 5.3                  |                     | 6.7                           | dB                           |
| AGC range                                                              |                                                                                                                                                                          | $AGC_{range}$                                                                                                                                                                  | 39.9                 |                     | 44.1                          | dB                           |
| Analog ground reference output voltage                                 | Load current $\pm 300\text{ }\mu\text{A}$                                                                                                                                | $V_{REF\_OUT}$                                                                                                                                                                 | 1.52                 | 1.65                | 1.78                          | V                            |
| Signal to noise ratio (Notes 18 and 20)                                | Signal amplitude of 62.5% of the full scale of the ADC                                                                                                                   | $SN_{AD\_OUT}$                                                                                                                                                                 | 54                   |                     |                               | dB                           |
| Clipping level at the output of the gain stage (RX_OUT)                |                                                                                                                                                                          | $V_{CLIP\_AGC\_IN}$                                                                                                                                                            | 1.05                 |                     | 1.65                          | $V_{PK}$                     |
| Receive cascade gain (Note 22)                                         | f = 10 kHz, A = 250 mVpk<br>f = 148.5 kHz, A = 250 mVpk<br>f = 195 kHz, A = 250 mVpk<br>f = 245 kHz, A = 250 mVpk<br>f = 500 kHz, A = 250 mVpk<br>f = 1 MHz<br>f = 2 MHz | $V_{RX\_LPF\_10kHz}$<br>$V_{RX\_LPF\_148.5kHz}$<br>$V_{RX\_LPF\_195kHz}$<br>$V_{RX\_LPF\_245kHz}$<br>$V_{RX\_LPF\_500kHz}$<br>$V_{RX\_LPF\_1000kHz}$<br>$V_{RX\_LPF\_2000kHz}$ | -0.5<br>-1.3<br>-4.5 | 0<br><br>-36<br>-50 | 0.5<br>0.5<br>-1<br>-3<br>-18 | dB                           |
| <b>POWER-ON-RESET (POR)</b>                                            |                                                                                                                                                                          |                                                                                                                                                                                |                      |                     |                               |                              |
| POR threshold (Note 23)                                                | $V_{DD}$ and $V_{DDA}$ rising                                                                                                                                            | $V_{PORH}$                                                                                                                                                                     |                      |                     | 2.7                           | V                            |
|                                                                        | $V_{DD}$ and $V_{DDA}$ falling                                                                                                                                           | $V_{PORL}$                                                                                                                                                                     | 2.1                  |                     |                               |                              |
| Power supply rise time                                                 | 0 to 3 V on both $V_{DD}$ and $V_{DDA}$                                                                                                                                  | $T_{RPOR}$                                                                                                                                                                     | 1                    |                     |                               | ms                           |
| <b>DIGITAL OUTPUTS: TDO, SCK, SDO, CSB, IO0..IO9</b>                   |                                                                                                                                                                          |                                                                                                                                                                                |                      |                     |                               |                              |
| Low output voltage (Note 24)                                           | $I_{XOUT} = 4\text{ mA}$                                                                                                                                                 | $V_{OL}$                                                                                                                                                                       |                      |                     | 0.4                           | V                            |
| High output voltage (Note 24)                                          | $I_{XOUT} = -4\text{ mA}$                                                                                                                                                | $V_{OH}$                                                                                                                                                                       | $0.85 V_{DD}$        |                     |                               | V                            |
| <b>DIGITAL OUTPUTS WITH OPEN DRAIN: TX_ENB, TXD, DATA/PRES</b>         |                                                                                                                                                                          |                                                                                                                                                                                |                      |                     |                               |                              |
| Low output voltage                                                     | $I_{XOUT} = 4\text{ mA}$                                                                                                                                                 | $V_{OL}$                                                                                                                                                                       |                      |                     | 0.4                           | V                            |
| <b>DIGITAL INPUTS: BR0, BR1</b>                                        |                                                                                                                                                                          |                                                                                                                                                                                |                      |                     |                               |                              |
| Low input level                                                        |                                                                                                                                                                          | $V_{IL}$                                                                                                                                                                       |                      |                     | $0.2 V_{DD}$                  | V                            |
| High input level                                                       | 0 to 3 V                                                                                                                                                                 | $V_{IH}$                                                                                                                                                                       | $0.8 V_{DD}$         |                     |                               | V                            |
| Input leakage current                                                  |                                                                                                                                                                          | $I_{LEAK}$                                                                                                                                                                     | -2                   |                     | 2                             | $\mu\text{A}$                |

18. Input at RX\_IN, no other external components.

19. Characterization data only. Not tested in production.

20. A sinusoidal signal of 100 mVpp is injected between VDDA and VSSA. The signal level at the differential LPF\_OUT and REF\_OUT output is measured to determine the parameter. The AGC gain is fixed at 42 dB.

21. These parameters will be tested in production with an input signal of 95 kHz and 1  $V_{PK}$  by reading out the digital samples at the output of the ADC. The AGC gain is switched to 0 dB.

22. The cascade of the receive low-pass filter (LPF), AGC and low noise amplifier is production tested and must have a frequency characteristic between the limits listed. The level is specified relative to the level at DC; the absolute output level will depend on the operating condition. This test is done with the low-pass filter (LPF) tuned to include the CENELEC D-band.

23. The nominal voltage on the pins VDD and VDDA (the digital and analog power supply) must be equal; both supply rail must be switched together.

24. For IO0..IO9, this parameter only applies if the pin is configured as output pin by the firmware.

**Table 5. ELECTRICAL CHARACTERISTICS**

All parameters are valid for  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ ,  $f_{CLK} = 48\text{ MHz} \pm 50\text{ ppm}$  unless otherwise specified.

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
|-----------|-----------------|--------|-----|-----|-----|------|
|-----------|-----------------|--------|-----|-----|-----|------|

**DIGITAL INPUTS WITH PULL-DOWN: TDI, TMS, TCK, TRSTB, TEST, SEN, IO8, IO9**

|                              |                                    |          |              |     |              |           |
|------------------------------|------------------------------------|----------|--------------|-----|--------------|-----------|
| Low input level (Note 25)    |                                    | $V_{IL}$ |              |     | $0.2 V_{DD}$ | V         |
| High input level (Note 25)   |                                    | $V_{IH}$ | $0.8 V_{DD}$ |     |              | V         |
| Pull-down resistor (Note 25) | Measured at $V_{Pin} = V_{DD} / 2$ | $R_{PU}$ | 35           | 100 | 170          | $k\Omega$ |

**DIGITAL SCHMITT TRIGGER INPUTS: RXD, RESB, IO0..IO7, SDI**

|                                   |  |            |              |  |               |               |
|-----------------------------------|--|------------|--------------|--|---------------|---------------|
| Rising threshold level (Note 26)  |  | $V_{T+}$   |              |  | $0.80 V_{DD}$ | V             |
| Falling threshold level (Note 26) |  | $V_{T-}$   | $0.2 V_{DD}$ |  |               | V             |
| Input leakage current (Note 26)   |  | $I_{LEAK}$ | -2           |  | 2             | $\mu\text{A}$ |

**BOOT LOADER TIMING** (Parameters are valid for a baud rate of 115'200) (Note 27)

|                                                                |                   |           |    |     |     |               |
|----------------------------------------------------------------|-------------------|-----------|----|-----|-----|---------------|
| IO2 setup time to falling edge of RESB                         | (Note 28)         | $t_{2s}$  | 5  |     |     | $\mu\text{s}$ |
| Boot loader startup time                                       | (Notes 28 and 29) | $t_{stx}$ |    | 135 | 200 | ms            |
| Inter-byte timeout sent to modem                               | (Note 28)         | $t_{IB}$  |    |     | 20  | ms            |
| Boot loader acknowledgement after last byte correctly received | (Note 28)         | $t_{ACK}$ |    | 3.6 | 12  | ms            |
| IO2 hold time after start of acknowledgement byte transmission | (Note 28)         | $t_{2h}$  | 36 |     |     | $\mu\text{s}$ |

25. For IO8 and IO9, this parameter only applies if the pin is configured as input pin by the firmware.

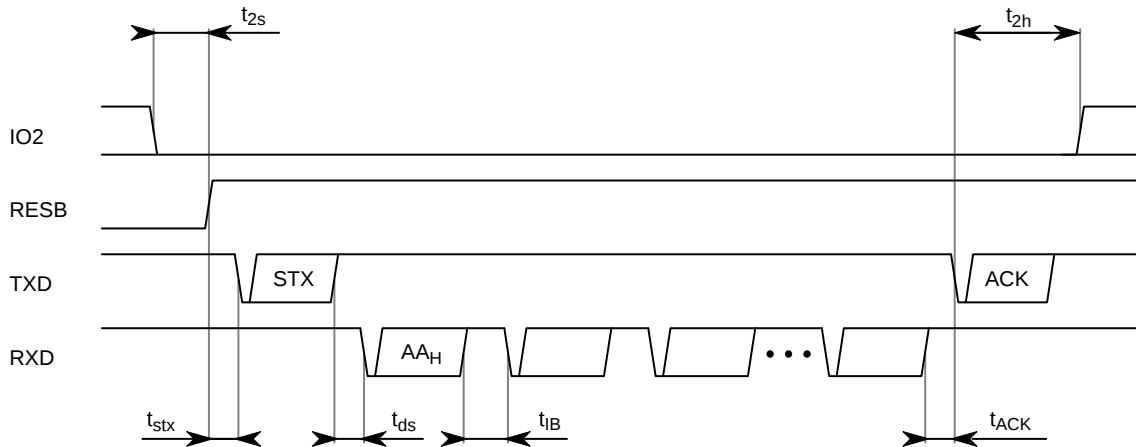
26. For IO0...IO7, this parameter only applies if the pin is configured as input pin by the firmware.

27. The timing constraints governing the boot loader when uploading firmware over the serial interface are illustrated in Figure 3.

28. These parameters will not be measured in production as the performance is determined by a digital circuit.

29. This parameter is specified with the oscillator stable. Refer to  $T_{startup}$  for oscillator startup information.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

**Figure 3. Timing Constraints for Uploading the Firmware over the Serial Communication Interface (SCI)**

Typical Performance Characteristics

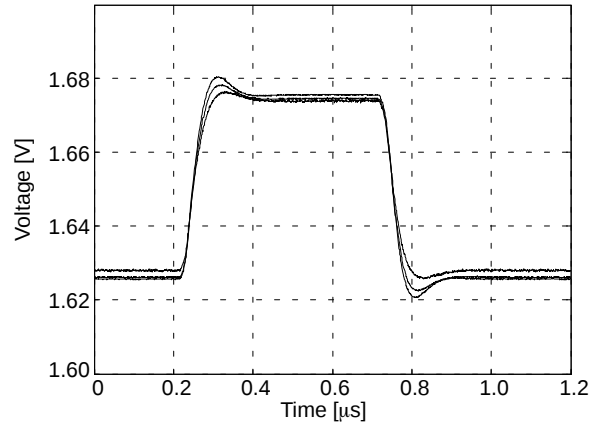


Figure 4. Receiver Opamp — Small signal transient response for (top to center) no load, 10 kΩ load, 3.6 kΩ load

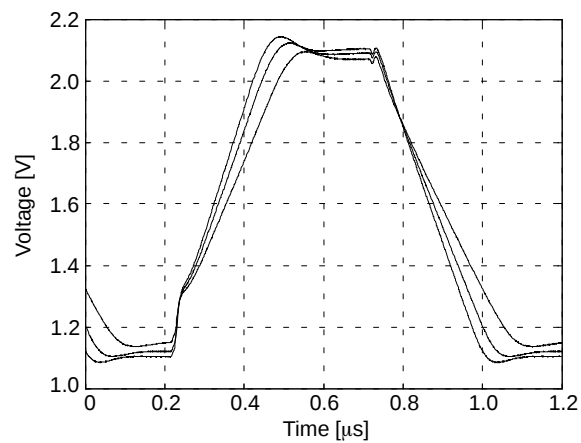


Figure 5. Receiver Opamp — Large signal transient response for (top to center) no load, 10 kΩ load, 3.6 kΩ load

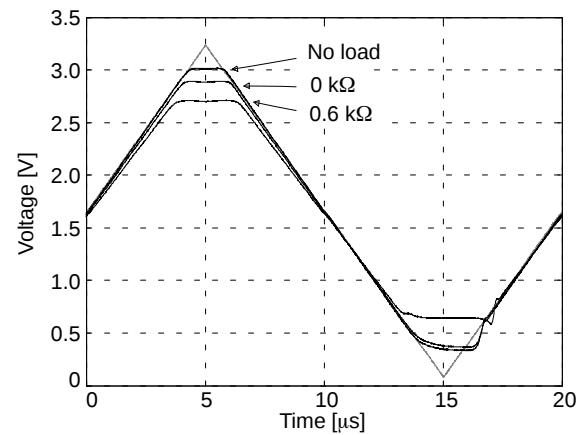


Figure 6. Receiver Opamp — Output overdrive recovery behavior. The input signal is shown in grey

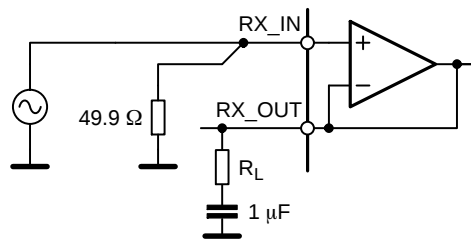


Figure 7. Test Circuit for Figures 4–6

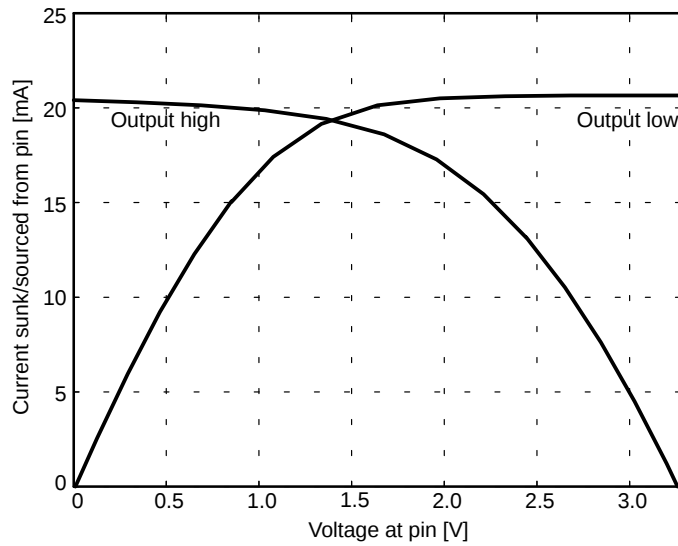


Figure 8. GPIO Current Sourcing and Sinking Capability

## General Description

The NCN49597 is a single chip half duplex S-FSK modem designed for hostile communication environments with very low signal-to-noise ratio (SNR) and high interference. It is particularly suited for power line carrier (PLC) data transmission on low-or medium-voltage power lines.

Together with firmware, the device handles of the lower layers of communication protocols. Firmware solutions are provided by ON Semiconductor royalty-free for the ON-PL110 protocol. It handles the physical, Media Access Control (MAC) and Logical Link Control (LLC) layers on-chip. For more information, refer to the dedicated software datasheet.

Because the lower layers are handled on-chip, the NCN49597 provides an innovative architectural split. The user benefits from a higher level abstraction. Compared to a low-level interface, the NCN49597 allows faster development of applications: the user just needs to send the raw data to the NCN49597 and no longer has to take care of the details of the transmission over the specific medium. The latter part easily represents half of the software development cost.

Figure 9 shows the building blocks of the NCN49597. Refer to the sections below for a detailed description.

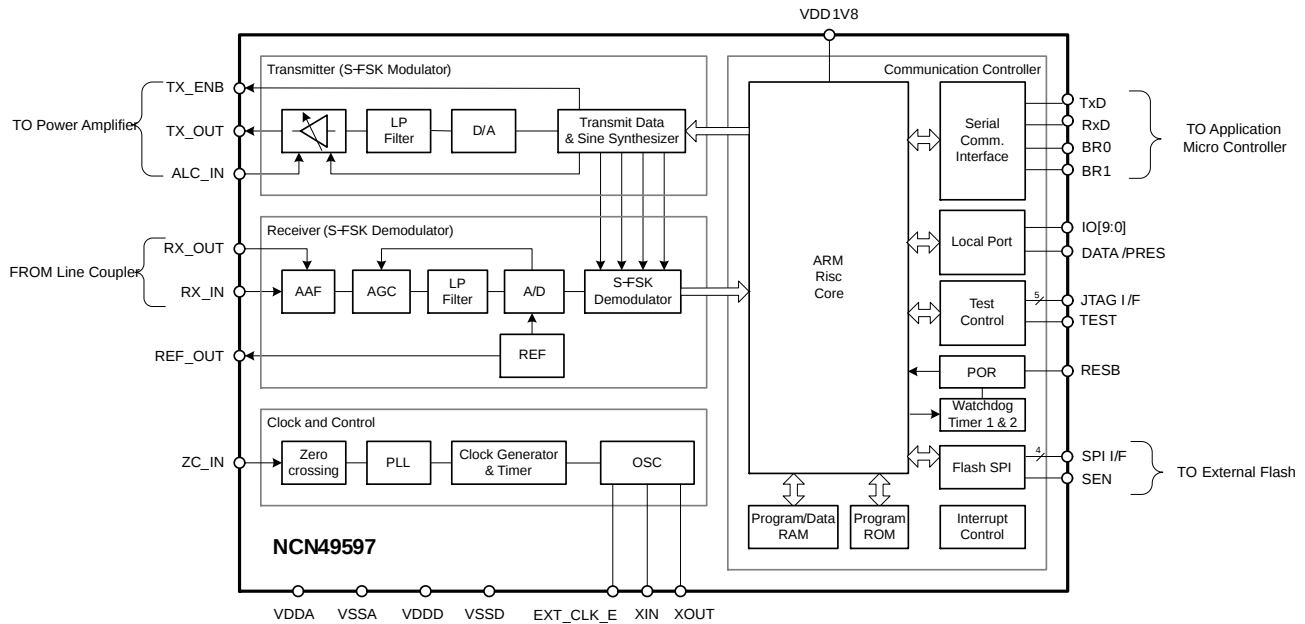


Figure 9. Block Diagram of the NCN49597 S-FSK Modem

NCN49597 complies with the CENELEC EN 50065-1 and EN 50065-7 standards. It operates from a single 3.3 V power supply and is interfaced to the power line by an external line driver and transformer. An internal PLL is locked to the mains frequency and is used to synchronize the data transmission at data rates of 300, 600, 1200, 2400 and 4800 baud for a 50 Hz mains frequency, or 360, 720, 1440, 2880 and 5760 baud for a 60 Hz mains frequency. In both cases this corresponds to 3, 6, 12 or 24 data bits per half cycle of the mains period.

S-FSK is a modulation and demodulation technique that combines some of the advantages of a classical spread spectrum system (e.g. immunity against narrow band interferers) with the advantages of the classical FSK system (low complexity). The transmitter assigns the space frequency  $f_s$  to "data 0" and the mark frequency  $f_m$  to "data 1". In contrast to classical FSK, the modulation carriers  $f_s$  and  $f_m$  used in S-FSK are placed well apart. As interference and signal attenuation seen at the carrier

frequencies are now less correlated, this results in making their transmission quality independent from each other. Thus, more robust communication is possible in interference-prone environments. The frequency pairs supported by the NCN49597 are in the range of 9–150 kHz with a typical separation of 10 kHz.

The conditioning and conversion of the signal is performed at the analog front-end of the circuit. All further processing of the signal and the handling of the protocol is fully digital. The digital processing of the signal is partitioned between hardwired blocks and a microprocessor block. Where timing is most critical, the functions are implemented with dedicated hardware. For the functions where the timing is less critical – typically the higher level functions – the circuit makes use of an integrated ARM microprocessor core. An internal random-access memory (RAM) stored the firmware and the working data.

After the modem has been reset, the user must upload the firmware into the modem memory. This may be done over

the asynchronous serial interface (discussed below); alternatively, the modem can autonomously retrieve the firmware from an attached SPI memory. For details, refer to the Boot Loader section.

The modem communicates to the application microcontroller over a Serial Communication Interface (SCI), a standard asynchronous serial link, which allows interfacing with any microcontroller with a free UART. The SCI works on two wires: TXD and RXD. The baud rate is programmed by setting two pins (BR0, BR1).

The NCN49597, together with an NCS5651 line driver, is functionally equivalent to the NCN49599 modem. Thus, the same user software works equally well with the NCN49597 as with the NCN49599.

### **Converting AMIS-49587-based Designs to NCN49597**

The NCN49597 is designed to allow easy adaptation of printed circuit board designs using the AMIS-49587. All connected pins of the latter (QFN package) are present in the same location in the NCN49597.

Four important hardware changes must be noted.

Most of the not-connected (NC) pins of the AMIS-49587 are functional in the NCN49597. If these pins were previously connected to ground (a commendable practice)

this must be taken into account. IO4–IO10 are usually configured as inputs and can therefore be grounded safely. However, it must be considered that some NC pins of AMIS-49587 are outputs in the NCN49597. These include pins SDO, SCK and, CSB. IO0 and IO1 are used typically used by the firmware as status indicators. IO3 is used by the ON PL110 firmware for controlling the amplifier enable signal.

Secondly, the NCN49597 incorporates an internal 1.8 V regulator to power the digital core. For stability, a 1  $\mu$ F capacitor to ground must be connected on pin 19 (VDD1V8).

In addition, the lowest baud rate setting of the AMIS-49587 serial interface (BR0 & BR1 pulled low; 4800 baud) has been replaced by 115200 baud. All other BR0 and BR1 settings will result in the same baud rate.

Finally, a 48 MHz crystal is required for the NCN49597; the AMIS-49587 used a 24 MHz crystal.

The firmware running on the modem has been updated substantially compared to the AMIS-49587. As a result, the interface protocol between the user microcontroller and the modem is completely different. Refer to the firmware datasheet for details.

## Detailed Hardware Description

### Clock and Control

The clock and control block (Figure 10) provides the modem with the clock and synchronization signals required

for correct data transmission and reception. It is composed of the zero-crossing detector, phase locked loop (PLL), oscillator and clock generator.

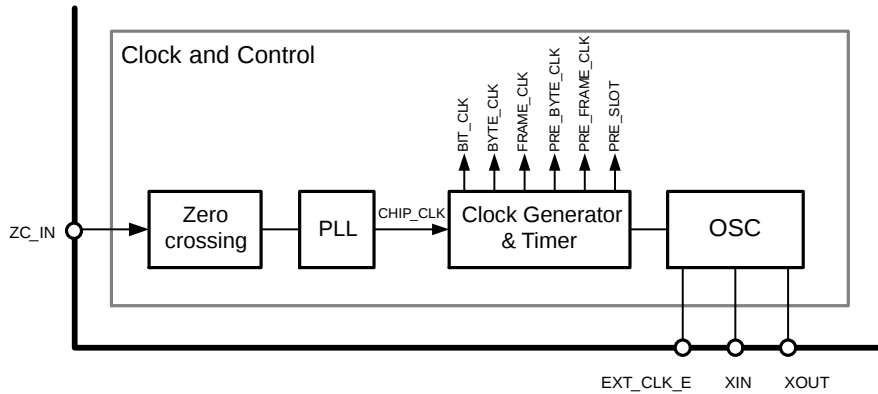


Figure 10. Clock and Control Block

### Oscillator

The NCN49597 may be clocked from a crystal with the built-in oscillator or from an external clock. XIN is the input to the oscillator inverter gain stage; XOUT the output. XOUT cannot be used directly as a clock output as no additional loading is allowed on the pin due to the limited voltage swing. This applies both to operation with a crystal and an external oscillator.

If an external clock of 48 MHz is to be used, the pin EXT\_CLK\_E must be pulled to  $V_{DD}$  and the clock signal connected to XIN. Note that the high level on XIN must not exceed the voltage of the internal voltage regulator ( $V_{DD18}$ , or about 1.8 V). The output must be floating.

If a crystal is to be used, the pin EXT\_CLK\_E should be strapped to  $V_{SSA}$  and the circuit illustrated in Figure 11 should be employed.

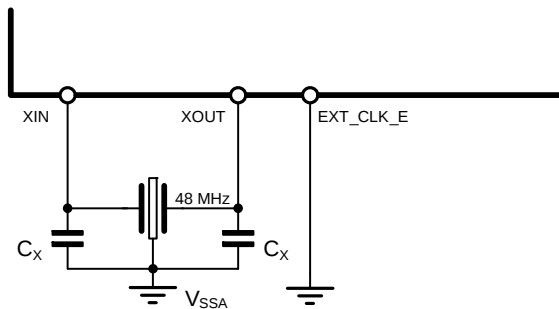


Figure 11. Clocking the NCN49597 with a Crystal

Correct operation is only possible with a parallel resonance crystal of 48 MHz. A crystal with a load capacitance  $C_L$  of 18 pF is recommended.

The load capacitance is the circuit capacitance appearing between the crystal terminals; it must be within the range

specified by the crystal manufacturer for correct operation at the desired frequency.  $C_L$  is determined by the external capacitors  $C_X$  and stray capacitance ( $C_{STRAY}$ ):

$$C_L = C_X / 2 + C_{STRAY}$$

Stray capacitance typically ranges from 2 to 5 pF. This results in a typical  $C_X$  value of 33 pF.

The printed circuit board should be designed to minimize stray capacitance and capacitive coupling to other parts by keeping traces as short as possible. The quality of the ground plane below the oscillator components is critical.

To guarantee startup, the series loss resistance of the crystal must be smaller than 60  $\Omega$ .

The oscillator output  $f_{CLK}$  (48 MHz) is the base clock for the entire modem. The microcontroller clock,  $f_{ARM}$ , is taken directly from  $f_{CLK}$ . The clock for the transmitter,  $f_{TX\_CLK}$ , is equal to  $f_{CLK} / 4$  or 12 MHz; the master receiver clock,  $f_{RX\_CLK}$ , equals  $f_{CLK} / 8$  or 6 MHz. All the internal clock signals of the transmitter and the receiver will be derived from  $f_{TX\_CLK}$  resp.  $f_{RX\_CLK}$ .

### Zero Crossing Detector

Depending on the standard and the application, synchronization with the mains zero crossing may be required.

In order to recover this timing information, a zero cross detection of the mains is performed.

Recommended circuits for the detection of the mains zero crossing appear in the Application Note "Mains synchronization for PLC modems". In case of the modem is not isolated from the mains a series resistor of 1 M $\Omega$  in combination with two external Schottky clamp diodes is recommended (Figure 12). This will limit the current flowing through the internal protection diodes.

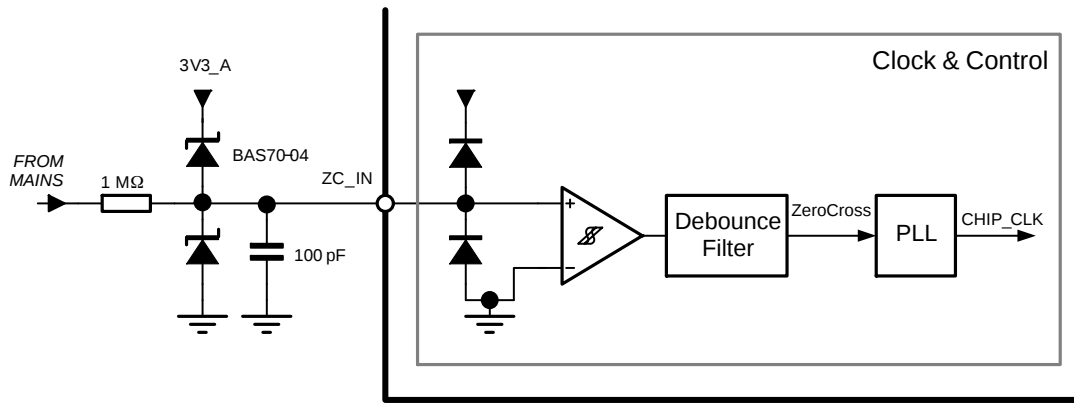


Figure 12. Zero Crossing Detector with Falling-edge De-bounce Filter

ZC\_IN is the mains frequency sense pin. A comparator with Schmitt trigger ensures a signal with edges, even in the presence of noise. In addition, the falling edges of the detector output are de-bounced with a delay of 0.5–1 ms. Rising edges are not de-bounced.

Because the detector threshold is not 0 V but slightly positive, the rising edge of the output is delayed compared to the actual rising mains zero crossing (Figure 13).

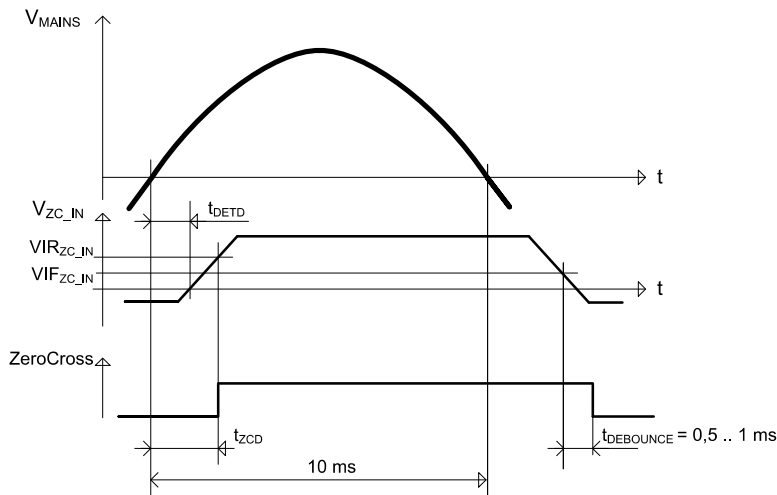


Figure 13. Zero Crossing Detector Signals and Timing (example for 50 Hz)

#### Phase Locked Loop (PLL)

A phase-locked loop (PLL) structure converts the signal at the ZC\_IN comparator output to the chip clock (CHIP\_CLK). This clock is used for modulation and demodulation and runs 8 times faster than the bit rate; as a result, the chip clock frequency depends on the mains frequency and the baud rate.

The filters of the PLL are dependent on the baud rate and the mains frequency. They must be correctly configured

using the register R\_CONF. The bit R\_CONF[0] specifies the mains frequency, with a cleared bit (0) corresponding to 50 Hz; a set bit (1) to 60 Hz. The bits R\_CONF[2:1] control the number of data bits per mains period. The values 00b, 01b, 10b and 11b correspond to 6, 12, 24 and 48 bits per mains period of 20 ms (50 Hz) or 16.7 ms (60 Hz).

Together this results in the baud rates and chip clock frequencies shown in Table 6.

Table 6. CHIP\_CLK IN FUNCTION OF SELECTED BAUD RATE AND MAINS FREQUENCY

| R_CONF[0] | Mains frequency | R_CONF[2:1] | Baudrate | CHIP_CLK |
|-----------|-----------------|-------------|----------|----------|
| 0         | 50 Hz           | 00b         | 300 bps  | 2400 Hz  |
|           |                 | 01b         | 600 bps  | 4800 Hz  |
|           |                 | 10b         | 1200 bps | 9600 Hz  |
|           |                 | 11b         | 2400 bps | 19200 Hz |
| 1         | 60 Hz           | 00b         | 360 bps  | 2880 Hz  |
|           |                 | 01b         | 720 bps  | 5760 Hz  |
|           |                 | 10b         | 1440 bps | 11520 Hz |
|           |                 | 11b         | 2880 bps | 23040 Hz |

The PLL significantly reduces the clock jitter. This makes the modem less sensitive to timing variations; as a result, a cheaper zero crossing detector circuit may be used.

The PLL input is only sensitive to rising edges. If no zero crossings are detected, the PLL freezes its internal timers in order to maintain the CHIP\_CLK timing.

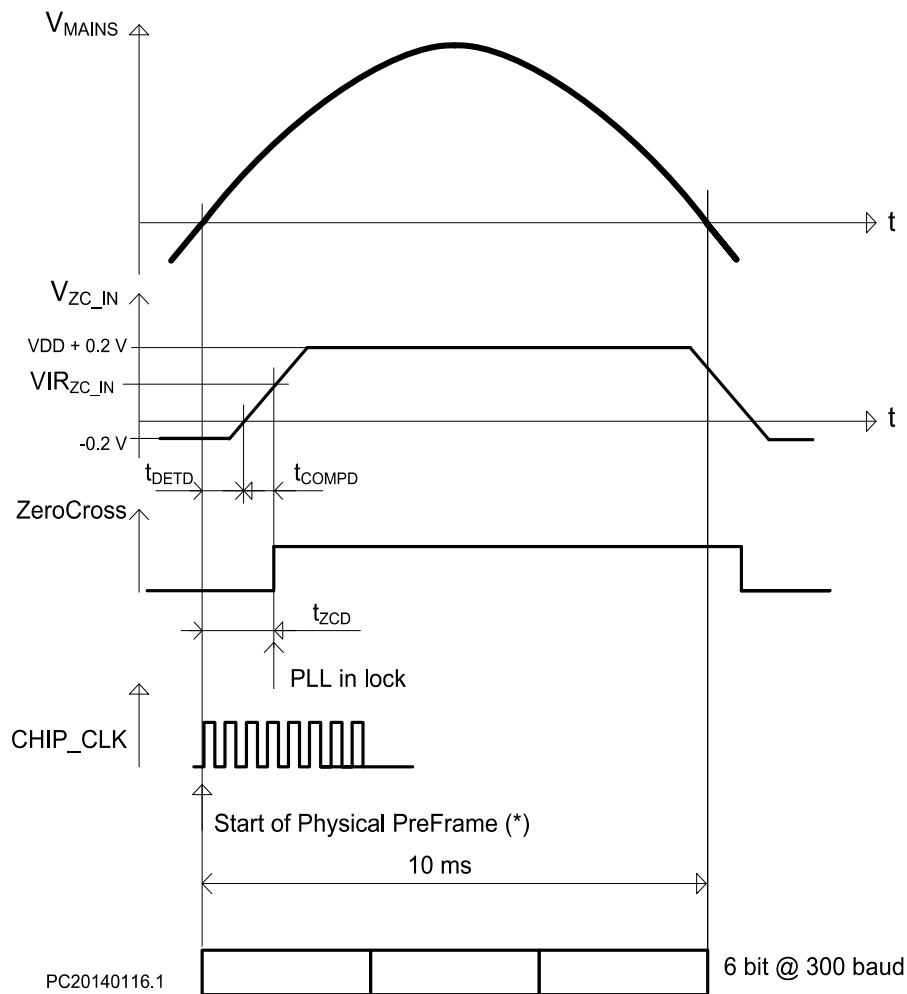


Figure 14. Using the ZC\_ADJUST Register to Compensate for Zero Crossing Delay (example for 50 Hz)

The PLL ensures the generated chip clock is in phase with the rising edge of comparator output. However, these edges are not precisely in phase with the mains.

Inevitably, the external zero crossing detector circuit suffers from a delay  $t_{DETD}$  (e.g. caused by an optocoupler). In addition, the comparator threshold is not zero ( $V_{RZC\_IN} = 1.9\text{ V}$ ); this results in a further delay,  $t_{COMP0}$  between the rising edge of the signal on pin ZC\_IN and the rising edge on the comparator output (as noted before, the PLL takes only the rising edge into account).

The combination of these delays would cause the modem to emit and receive data frames too late.

Therefore, the PLL allows tuning the phase difference between its input and the chip clock. The CHIP\_CLK may be brought forward by setting the register R\_ZC\_ADJUST. The adjustment period or granularity is  $13\text{ }\mu\text{s}$ , with a maximum adjustment of  $255 \times 13\text{ }\mu\text{s} = 3.3\text{ ms}$ , corresponding with a sixth of the 50 Hz mains sine period.

This is illustrated in Figure 9. The “physical frame” (i.e., the modulated signal appearing on the mains) starts earlier with R\_ZC\_ADJUST[7:0]  $\times 13\text{ }\mu\text{s}$  to compensate for the zero cross delay.

The delay corresponding with the value of R\_ZC\_ADJUST is also listed in Table 7.

**Table 7. ZERO CROSSING DELAY COMPENSATION**

| R_ZC_ADJUST[7:0] | Compensation                  |
|------------------|-------------------------------|
| 0000 0000        | 0 $\mu\text{s}$ (reset value) |
| 0000 0001        | 13 $\mu\text{s}$              |
| 0000 0010        | 26 $\mu\text{s}$              |
| 0000 0011        | 39 $\mu\text{s}$              |
| ...              | ...                           |
| 1111 1111        | 3315 $\mu\text{s}$            |

### Clock Generator and Timer

The timing generator (Figure 10, center) is responsible for all synchronization signals and interrupts related to S-FSK communication.

The timing is derived from the chip clock (CHIP\_CLK, generated by the PLL) and the main oscillator clock  $f_{CLK}$ . The timing has a fixed repetition rate, corresponding to the length of a physical subframe (see reference [1]).

When the NCN49597 switches between receive and transmit mode, the chip clock counter value is maintained. As a result, the same timing is maintained for reception and transmission. Seven timing signals are defined:

- **CHIP\_CLK** is the output of the PLL and the input of the timing generator. It runs 8 times faster than the bit rate on the physical interface.
- **BIT\_CLK** is only active at chip clock counter values that are multiples of 8 (0, 8, ..., 2872). It indicates the start of the transmission of a new bit.
- **BYTE\_CLK** is only active at chip clock counter values that are multiples of 64 (0, 64, ..., 2816). It indicates the start of the transmission of a new byte.
- **FRAME\_CLK** is only active at counter value 0; it indicates the transmission or reception of a new frame.
- **PRE\_BYTE\_CLK** follows the same pattern as BYTE\_CLK, but precedes it by 8 chip clocks. It can be used as an interrupt for the internal microcontroller and indicates that a new byte for transmission must be generated.
- **PRE\_FRAME\_CLK** follows the same pattern as FRAME\_CLK, but precedes it by 8 chip clocks. It can be used as an interrupt for the internal microcontroller and indicates that a new frame will start at the next FRAME\_CLK.
- **PRE\_SLOT** is active between the rising edge of PRE\_FRAME\_CLK and the rising edge of FRAME\_CLK. This signal can be provided at the digital output pin DATA/PRES when R\_CONF[7] = 0. Thus, the external host controller may synchronize its software with the internal FRAME\_CLK of the NCN49597. Refer to the SCI section and Table 11 for details.

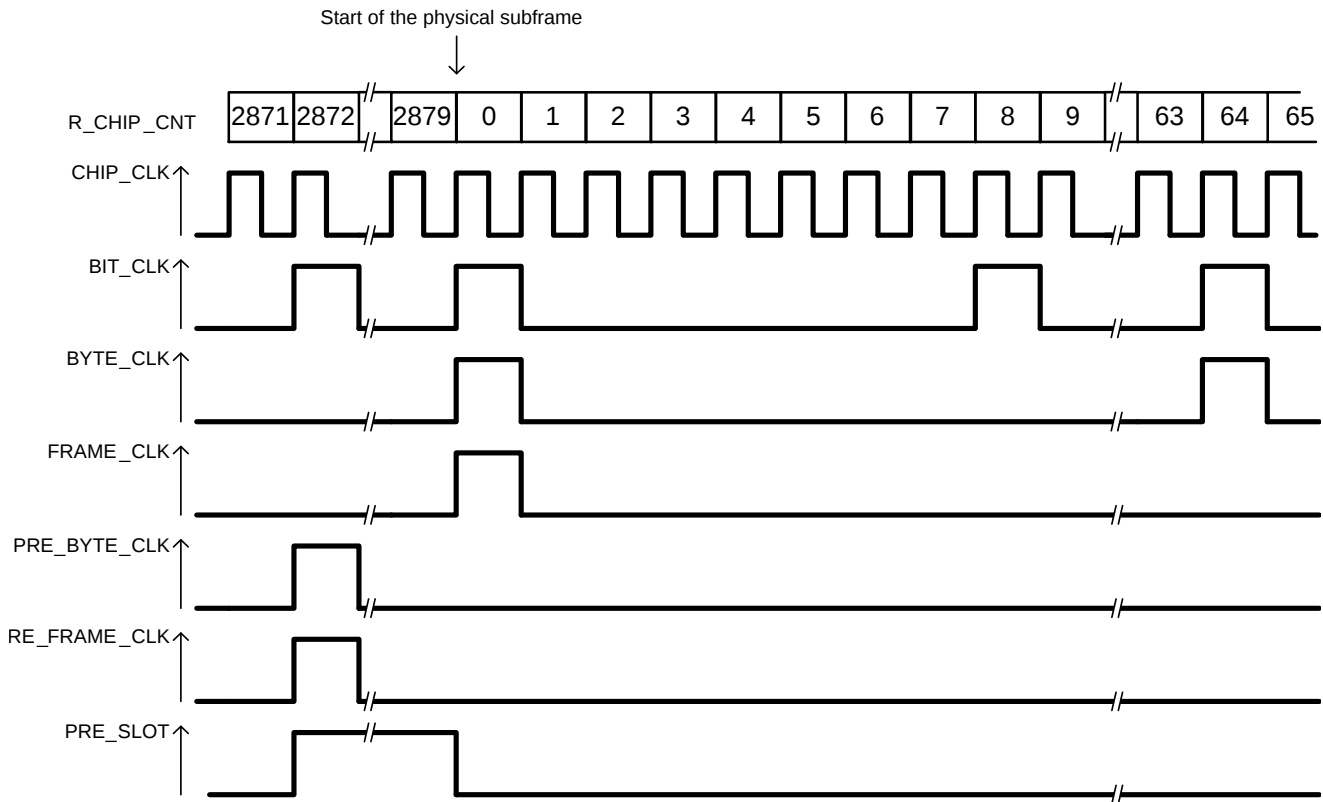


Figure 15. Timing Signals

#### Transmitter Path Description (S-FSK Modulator)

The NCN49597 transmitter block (Figure 16) generates the signal to be sent on the transmission channel. Most commonly, the output is connected to a power amplifier which injects the output signal on the mains through a line-coupler.

As the NCN49597 is a half-duplex modem, this block is not active when the modem is receiving.

The transmitter block is controlled by the microcontroller core, which provided the bit sequence to be transmitted. Direct digital synthesis (DDS) is employed to synthesize the modulated signal; after a conditioning step, this signal is converted to an analogue voltage. Finally, an amplifier with variable gain buffers the signal and outputs it on pin TX\_OUT.

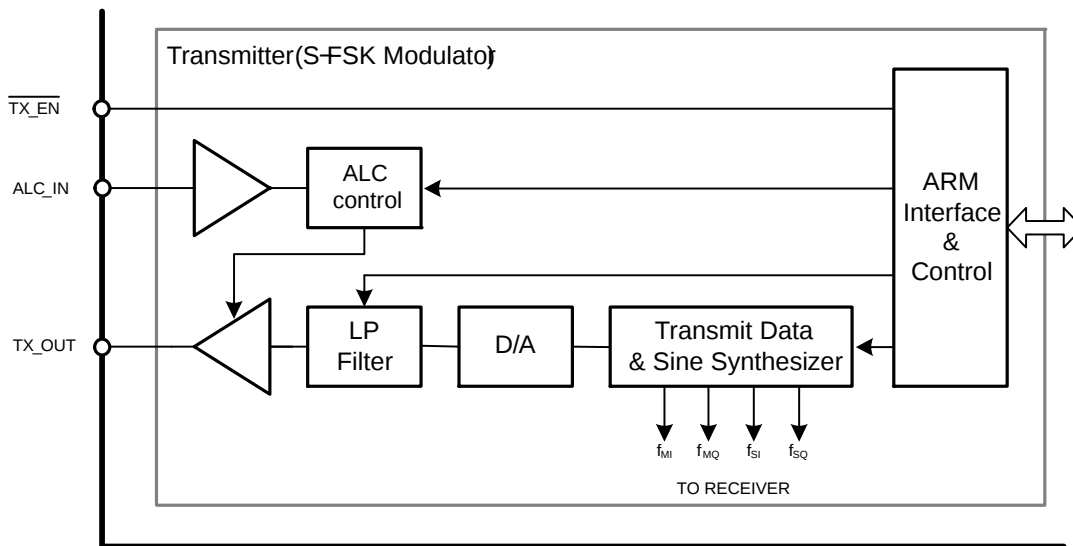


Figure 16. Transmitter Block Diagram

### Microcontroller Interface & Control

The interface with the internal ARM microcontroller consists of an 8-bit data register R\_TX\_DATA, 2 control registers R\_TX\_CTRL and R\_ALC\_CTRL, a flag TX\_RXB defining the operating mode (a high level corresponding to transmit mode; low to receive) and the frequency control registers. All these registers are memory mapped; most can be accessed through the firmware: refer to the specific firmware documentation for details.

### Sine Wave Generator

The direct digital synthesizer (DDS) generates a sinusoidal signal alternating between the space frequency ( $f_S$ , data 0) and the mark frequency ( $f_M$ , data 1) as required to modulate the desired bit pattern. Two 16-bit wide frequency step registers, R\_FM and R\_FS, control the steps used by the DDS and thus the frequencies.

The space and mark frequency can be calculated using

$$f_S = R\_FS[15:0]_{dec} \cdot f_{DDS}/2^{18}$$

$$f_M = R\_FM[15:0]_{dec} \cdot f_{DDS}/2^{18}$$

Equivalently, values for R\_FS[15:0] and R\_FM[15:0] may be calculated from the desired carrier frequencies

$$R\_FS[15:0]_{dec} = [2^{18} \cdot f_S / f_{DDS}]$$

$$R\_FM[15:0]_{dec} = [2^{18} \cdot f_M / f_{DDS}]$$

With  $f_{DDS} = 3$  MHz the direct digital synthesizer clock frequency and  $[x]$  equal to  $x$  rounded to the nearest integer.

At the start of the transmission the DDS phase accumulator starts at 0, resulting in a 0 V output level. Switching between  $f_M$  and  $f_S$  is phase-continuous. Upon switching to receive mode the DDS completes the active sine period. These precautions minimize spurious emissions.

### DA Converter and Anti-aliasing Filter

A digital to analogue  $\Sigma\Delta$  converter converts the sine wave digital word to a pulse density modulated (PDM) signal. The PDM stream is converted to an analogue signal with a first order switched capacitor filter.

A 3<sup>rd</sup> order continuous time low pass filter in the transmit path filters the quantization noise and noise generated by the  $\Sigma\Delta$  DA converter.

The -3 dB frequency of this filter can be set to 130 kHz for applications using the CENELEC A band. In this configuration, the response of the filter is virtually flat up to 95 kHz. Alternatively a -3 dB frequency of 195 kHz can be selected yielding a flat response for the entire CENELEC A to D band (i.e., up to 148.5 kHz). Refer to the documentation of the firmware for more information.

The low pass filter is tuned automatically to compensate for process variation.

### Amplifier with Automatic Level Control (ALC)

The analogue output of the low-pass filter is buffered by a variable gain amplifier; 8 attenuation steps from 0 to -21 dB (typical) with steps of 3 dB are provided.

The attenuation can be fixed by setting the bit R\_ALC\_CTRL[3]. The embedded microcontroller can then set the attenuation using register ALC\_CTRL[2:0]. This

register is usually made available by the firmware to the application microcontroller. The attenuations corresponding to R\_ALC\_CTRL[2:0] values are given in Table 8.

**Table 8. FIXED TRANSMITTER OUTPUT ATTENUATION**

| ALC_CTRL[2:0] | Attenuation |
|---------------|-------------|
| 000           | 0 dB        |
| 001           | -3 dB       |
| 010           | -6 dB       |
| 011           | -9 dB       |
| 100           | -12 dB      |
| 101           | -15 dB      |
| 110           | -18 dB      |
| 111           | -21 dB      |

Alternatively, automatic level control (ALC) may be used by clearing the bit R\_ALC\_CTRL[3].

In this mode, the signal on the analogue input pin ALC\_IN controls the transmitter output level. First, peak detection is performed. The peak value is then compared to two thresholds levels  $V_{TL\_ALC\_IN}$  and  $V_{TH\_ALC\_IN}$ . Depending on the value of the measured peak level on ALC\_IN the attenuation is updated using

$V_{PALC\_IN} < V_{TL\_ALC}$  :increase the level with one 3 dB step

$V_{TL\_ALC} \leq V_{PALC\_IN} \leq V_{TH\_ALC}$  :do not change the attenuation

$V_{PALC\_IN} > V_{TH\_ALC}$  :decrease the level with one 3 dB step

The gain changes in the next chip clock. Therefore, an evaluation phase and a level adjustment phase take two CHIP\_CLK periods. ALC operation is enabled only during the first 16 CHIP\_CLK cycles after switching to transmit mode.

Following reset, the level is set at minimum level (maximum attenuation). When switching to reception mode the last level is kept in memory. As a result the next transmit frame starts with the old level.

Note that the DC level on the ALC\_IN pin is fixed internally to 1.65 V. As a result, a coupling capacitor is usually required.

If the automatic level control feature is not used, the pin ALC\_IN may be left floating (not recommended) or tied to ground.

### Transmitter Output TX\_OUT

The transmitter output is DC coupled to the TX\_OUT pin. Because the entire analogue part of the NCN49597 is referenced to the analogue reference voltage REF\_OUT (about 1.65 V), a decoupling capacitor ( $C_1$  in Figure 17) is usually required.

To suppress the second and third order harmonic of the generated S-FSK signal it is recommended to use a low pass filter. Figure 17 illustrates an MFB topology of a 2<sup>nd</sup> order filter.

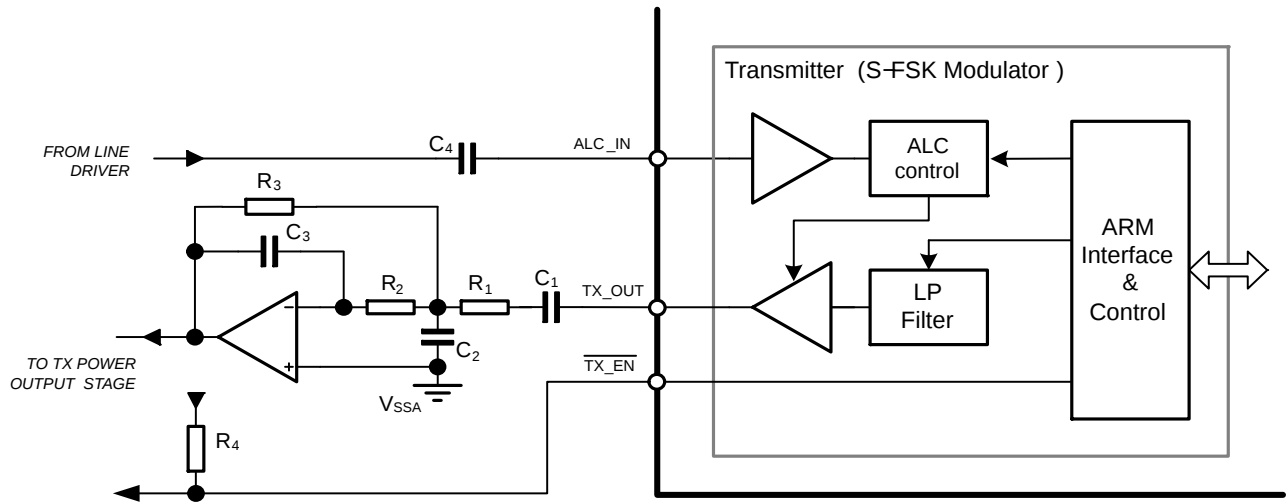


Figure 17. TX\_OUT Filter

The modem indicates whether it is transmitting or receiving on the digital output pin TX\_ENB. This is driven low when the transmitter is activated. The signal can be used to turn on an external line driver.

TX\_ENB is a 5 V safe with open drain output; an external pull-up resistor must be added (Figure 17, R<sub>4</sub>).

When the modem switches from transmit to receive mode, TX\_ENB is kept active (i.e., low) for a short period  $t_{dTX\_ENB}$  (Figure 13).

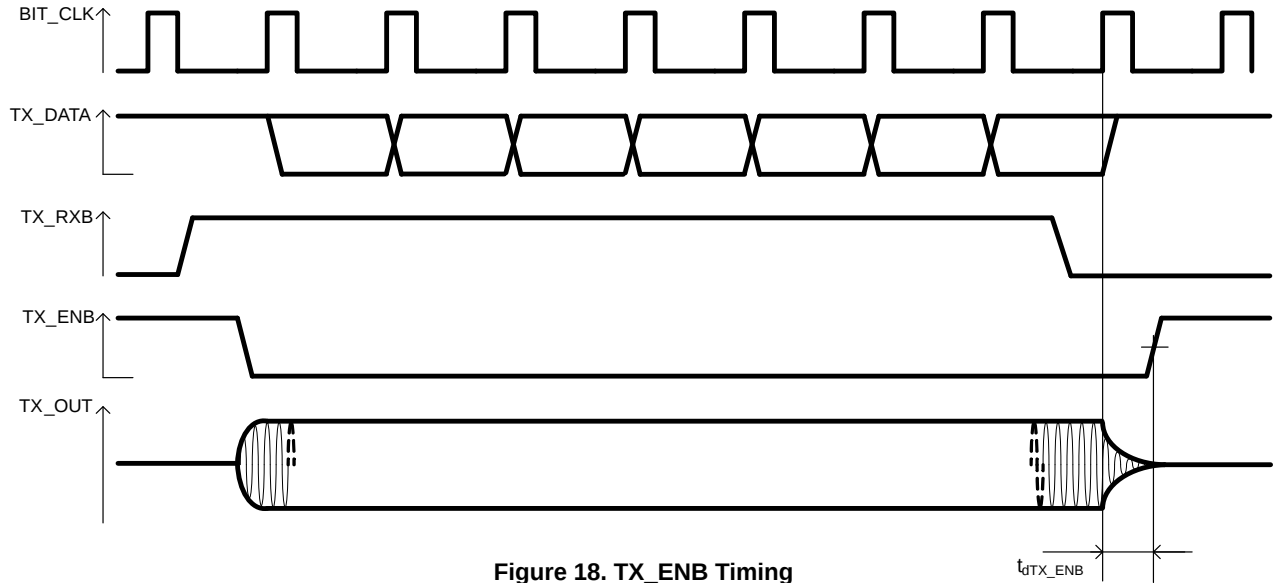


Figure 18. TX\_ENB Timing

### Receiver Path Description

The receiver demodulates the signal on the communication channel.

Typically, an external line coupling circuit is required to filter out the frequencies of interest on the communication channel.

The modem receiver block (Figures 19 and 22) filter, digitalizes and partially demodulates the output signal of the coupling circuit. Subsequently, the embedded microcontroller core will demodulate the resulting digital stream. The demodulation is described in the fact sheets of the various firmware solutions.

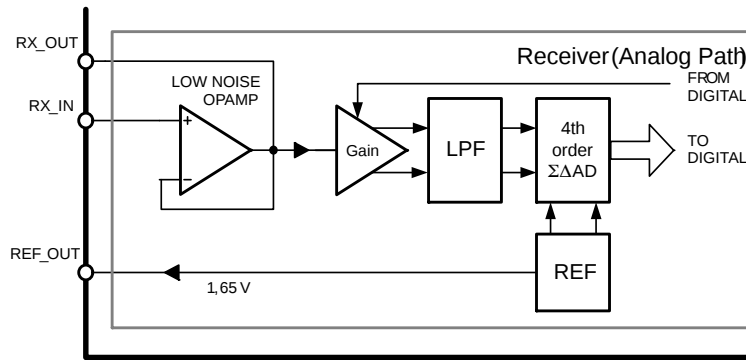


Figure 19. Analog Path of the Receiver Block

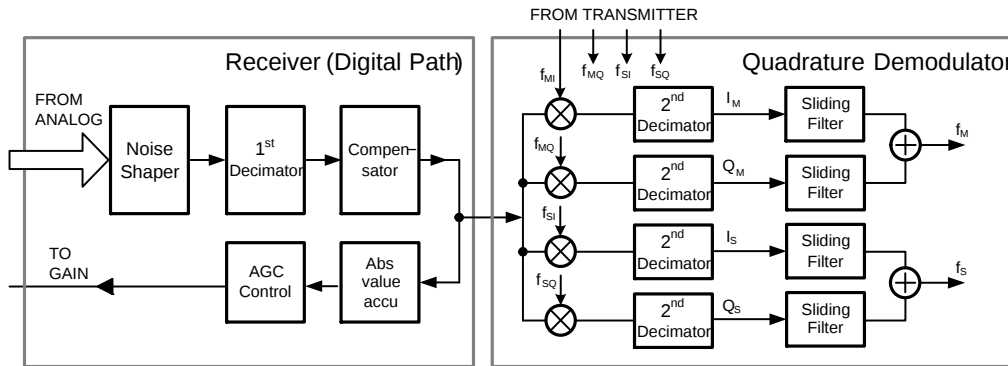


Figure 20. Digital Path of the Receiver Block

The receiver block is composed of an operation amplifier provided for filtering, a variable gain amplifier, an anti-aliasing low pass filter and analogue to digital convertor (ADC), and a digital quadrature downmixer.

When the modem is transmitting, the receive blocks are disabled to save power. The only exception is the low-pass filter, which is shared between receiver and transmitter and therefore remains active.

#### 50/60 Hz Suppression Filter

The line coupler – external to the modem and not described in this document – couples the communication channel to the low-voltage signal input of the modem. Ideally the signal produced by the line coupler would only contain the frequency band used by the S-FSK modulation.

For the common case of communication over an AC power line, a substantial 50 or 60 Hz residue is still present after the line coupler. This residue – typically much larger than the received signal – can easily overload the modem.

To improve communication performance, the NCN49597 provides a low-noise operational amplifier in a unity-gain configuration which can be used to make a 50/60 Hz suppression filter with only four external passive components. Pin RX\_IN is the non-inverting input and RX\_OUT is the output of the amplifier.

The internal reference voltage (described below) of 1.65 V is provided on REF\_OUT and can be used for this purpose. The current drawn from this pin should be limited to 300  $\mu$ A; in addition, adding a ceramic decoupling capacitor of at least 1  $\mu$ F is recommended.

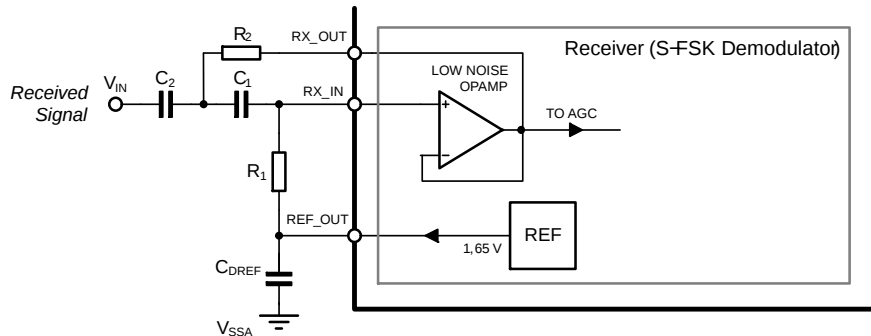


Figure 21. External Component Connection for 50/60 Hz Suppression Filter

The recommended topology is shown in Figure 20 and realizes a second order filter. The filter characteristics are determined by external capacitors and resistors. Typical values are given in Table 9 for carrier frequencies of 63.3 and

74.5 kHz; the resulting frequency response is shown in Figure 22. With a good layout, suppressing the residual mains voltage (50 or 60 Hz) with 60 dB is feasible. To design a filter for other frequencies, consult the design manual.

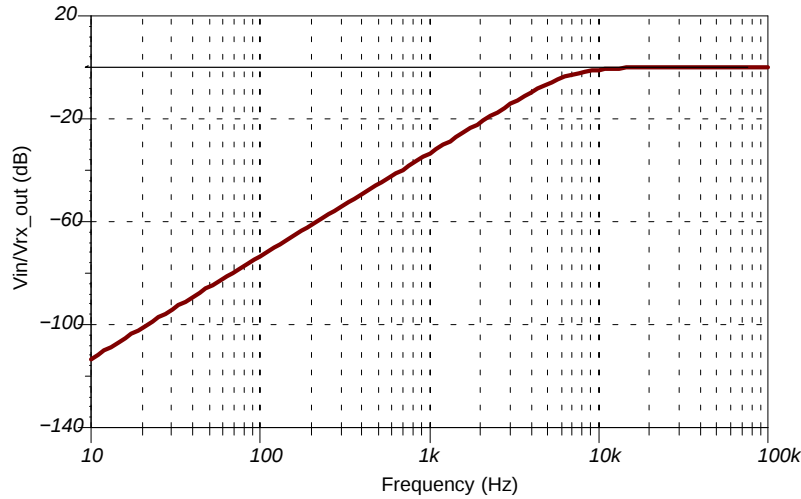


Figure 22. Transfer Function of the 50 Hz Suppression Circuit shown in Figure 17

Table 9.  
VALUE OF THE RESISTORS AND CAPACITORS

| Component         | Value | Unit |
|-------------------|-------|------|
| C <sub>1</sub>    | 1.5   | nF   |
| C <sub>2</sub>    | 1.5   | nF   |
| C <sub>DREF</sub> | 1     | μF   |
| R <sub>1</sub>    | 22    | kΩ   |
| R <sub>2</sub>    | 11    | kΩ   |

It is important to note that the analog part of NCN49597 is referenced to the internal analogue reference voltage REF\_OUT, with a nominal value of 1.65 V. As a result, the DC voltage on pin RX\_IN must be 1.65 V for optimal dynamic range. If the external signal has a substantially different reference level capacitive coupling must be used.

#### Automatic Gain Control (AGC)

In order to extend the range of the analogue-to-digital convertor, the receiver path contains a variable gain amplifier. The gain can be changed in 8 steps from 0 to -42 dB.

This amplifier can be used in an automatic gain control (AGC) loop. The loop is implemented in digital hardware. It measures the signal level after analogue-to-digital conversion. The amplifier gain is changed until the average digital signal is contained in a window around a percentage

of the full scale. An AGC cycle takes two chip clocks: a measurement cycle at the rising edge of the CHIP\_CLK and an update cycle starting at the next chip clock.

#### Low Noise Anti Aliasing Filter and ADC

The receiver has a 3<sup>rd</sup> order continuous time low pass filter in the signal path. This filter is in fact the same block as in the transmit path which can be shared because NCN49597 works in half duplex mode. The same choice of -3 dB frequency can be selected between 130 kHz (virtually flat up to 95 kHz) or 195 kHz (flat up to 148.5 kHz).

The output of the low pass filter is input for an analog 4<sup>th</sup> order sigma-delta converter. The DAC reference levels are supplied from the reference block. The digital output of the converter is fed into a noise shaping circuit blocking the quantization noise from the band of interest, followed by decimation and a compensation step.

#### Quadrature Demodulator

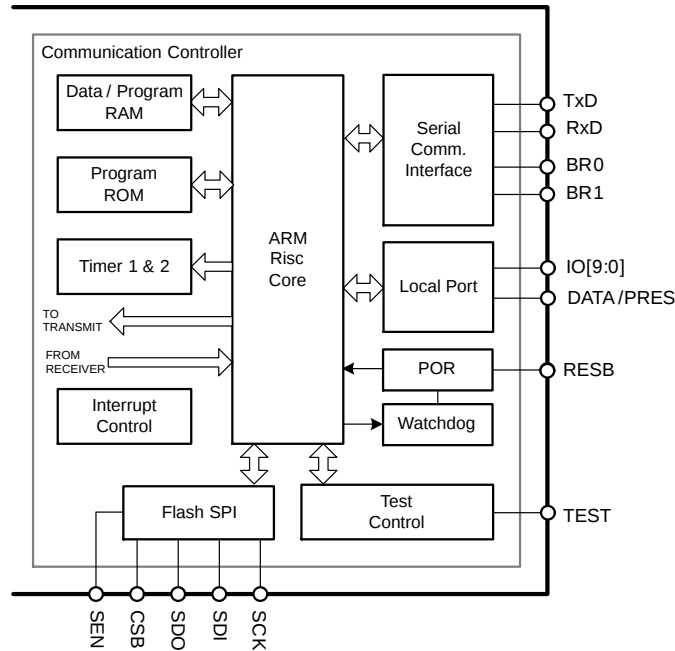
The quadrature demodulation block mixes the digital output of the ADC with the local oscillators. Mixing is done with the in-phase and quadrature phase of both the  $f_s$  and  $f_M$  carrier frequencies. Thus, four down-mixed (baseband) signals are obtained.

After low-pass filtering, the in-phase and quadrature components of each carrier are combined. The resulting two signals are a measure of the energy at each carrier frequency.

These energy levels are further processed in the firmware.

## Communication Controller

The Communication Controller block includes the micro-processor and its peripherals (refer to Figure 23 for an overview).



**Figure 23. The Communication Controller is Based on a Standard ARM Corex M0 Core**

The processor is an ARM Cortex M0 32-bit core with a reduced instruction set computer (RISC) architecture, optimized for IO handling. Most instructions complete in a single clock cycle, including byte multiplication. The peripherals include a watchdog, test and debug control, RAM, ROM containing the boot loader, UART, two timers, an SPI interface to optional external memory, I/O ports and the power-on reset. The microcontroller implements interrupts.

The 32 kB RAM contains the necessary space to store the firmware and the working data. A full-duplex serial communication block allows interfacing to the application microcontroller.

### Local Port

Ten bidirectional general purpose input/output (GPIO) pins (IO0..IO9) are provided. All general purpose IO pins can be configured as an input or an output. In addition, the firmware can emulate open-drain or open-source pins. All pins are 5 V tolerant.

When the modem is booting, IO2 is configured as an input and must be pulled low to enable uploading firmware over the serial interface. At the same time, IO0 and IO1 are configured as outputs and show the status of the boot loader. A LED may be connected to IO0 to help with debugging. After the firmware has been loaded successfully, IO0..IO2 become available as normal IOs.

Typically, the firmware provides status indication on some IO pins; other IO pins remain available to the application microcontroller as IO extensions.

The application microcontroller has also low-level access to internal timing of the modem through the digital output DATA/PRES pin. The function of this pin depends on the register bit R\_CONF[7].

If the bit is cleared (0), the preslot synchronization signal (PRE\_SLOT) appears on the pin.

If the bit is set (1), the modem outputs the baseband, unmodulated, data. Thus, DATA/PRES is driven high when a space symbol is being transmitted (i.e., the space frequency  $f_s$  appears on pin TX\_OUT); it is driven low when a mask symbol is transmitted ( $f_M$  on TX\_OUT).

### Testing

A JTAG debug interface is provided for development, debugging and production test. An internal pull-down resistor is provided on the input pins (TDI, TCK, TMS, and TRSTB).

In practice, the end user of the modem will not need this interface; this input pins may be tied to ground (recommended) or left floating; TDO should be left floating.

The pin TEST enables the internal hardware test mode when driven high. During normal operation, it should be tied to ground (recommended) or left floating.

### Serial Communication Interface (SCI)

The Serial Communication Interface allows asynchronous communication with any device incorporating a standard Universal Asynchronous Receiver Transmitter (UART).

The serial interface is full-duplex and uses the standard NRZ format with a single start bit, eight data bits and one stop bit (Figure 24). The baud rate is programmable from 9600 to 115200 baud through the BR0 and BR1 pins.

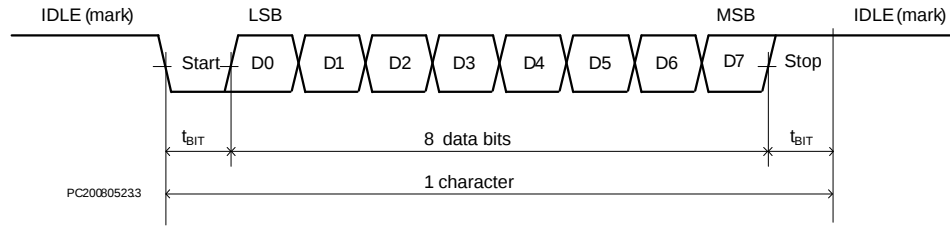


Figure 24. Data Format of the Serial Interface

Serial data is sent from the NCN49597 to the application microcontroller on pin TxD; data is received on pin RxD. Both pins are 5 V tolerant, allowing communication with both 3.3 V- and 5 V-powered devices.

On the open-drain output pin TxD an external pull-up resistor must be provided to define the logic high level (Figure 25). A value of 10 kΩ is recommended. Depending on the application, an external pull-up resistor on RxD may be required to avoid a floating input.

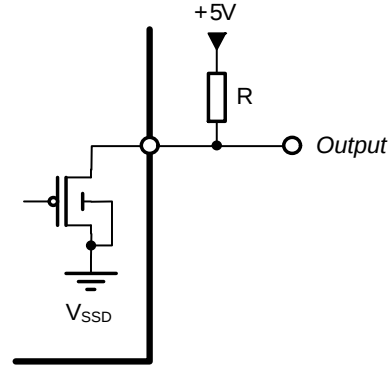


Figure 25. Interfacing to 5 V Logic using a 5 V Safe Output and a Pull-up Resistor

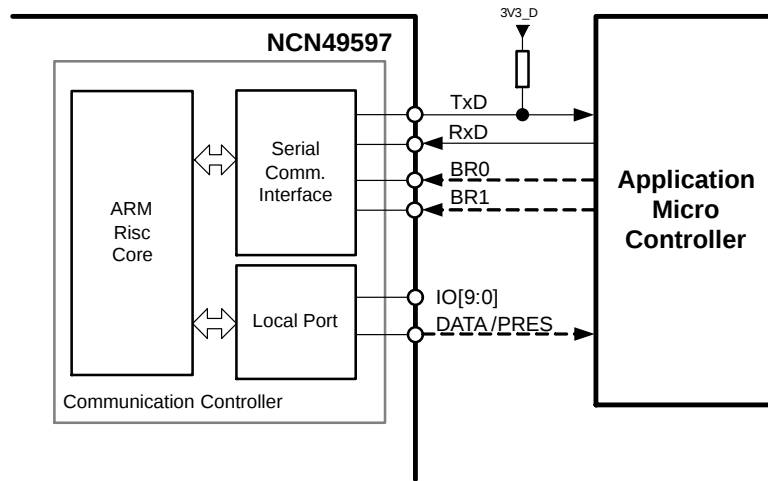


Figure 26. Connection to the Application Microcontroller

The baud rate of the serial communication is controlled by the pins BR0 and BR1. After reset, the logic level on these pins is read and latched; as a result, modification of the baud rate during operation is not possible. The baud rate derived from BR0 and BR1 is shown in Table 10.

Table 10. BR1, BR0 BAUD RATES

| BR1 | BR0 | SCI Baud Rate |
|-----|-----|---------------|
| 0   | 0   | 115200        |
| 0   | 1   | 9600          |
| 1   | 0   | 19200         |
| 1   | 1   | 38400         |

BR0 and BR1 are 5 V safe, allowing direct connection to 5 V-powered logic.

### Watchdog

A watchdog supervises the ARM microcontroller. In case the firmware does not periodically signal the watchdog it is alive, it is assumed an error has occurred and a hard reset is generated.

### Configuration Registers

The behavior of the modem is controlled by configuration registers. Some registers can be accessed by the user through the firmware. Table 11 gives an overview of some commonly exposed registers.

**Table 11. NCN49597 CONFIGURATION REGISTERS**

| Register         | Reset Value | Function                                                                                |
|------------------|-------------|-----------------------------------------------------------------------------------------|
| R_CONF[7]        | 0           | Pin DATA/PRES mode selection                                                            |
| R_CONF[2:1]      | 00b         | Baud rate selection                                                                     |
| R_CONF[0]        | 0           | Mains frequency                                                                         |
| R_FS[15:0]       | 0000h       | Step register for the space frequency fS                                                |
| R_FM[15:0]       | 0000h       | Step register for the mark frequency fM                                                 |
| R_ZC_ADJUST[7:0] | 02h         | Fine tuning of phase difference between CHIP_CLK and rising edge of mains zero crossing |
| R_ALC_CTRL[3]    | 0           | Automatic level control (ALC) enable                                                    |
| R_ALC_CTRL[2:0]  | 000b        | Automatic level control attenuation                                                     |

### Reset and Low Power

NCN49597 has two reset modes: hard reset and soft reset.

The hard reset re-initializes the complete IC (hardware and ARM) excluding the data RAM for the ARM. This guarantees correct start-up of the hardware and the microcontroller.

The modem is kept in hard reset as long as pin RESB is pulled low or the power supply  $V_{DD} < V_{POR}$  (See Table 11).

When switching on the power supply the output of the crystal oscillator is disabled until a few thousand clock pulses have been detected; this allows sufficient time for oscillator start-up.

When the pin RESB is pulled low the power consumption drops significantly. Power is drawn only to maintain the bias of some analogue functions and the oscillator cell.

### Boot Loader

During operation, the modem firmware is stored in the internal random access memory (RAM). As this memory is volatile, the firmware must be uploaded after reset.

The NCN49597 provides two mechanisms to achieve this: the firmware may be stored in an external SPI memory or it may be uploaded over the serial communication interface.

### Bootling from External Memory

During reset, the boot loader module in the modem can retrieve the firmware from an attached memory.

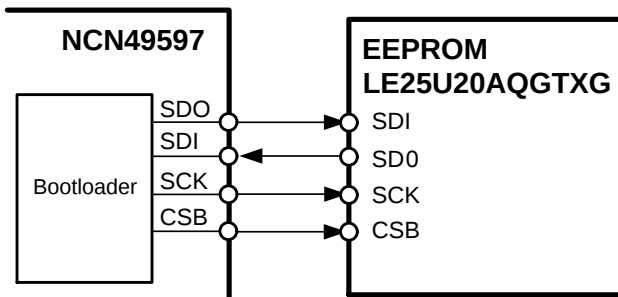
To enable this mode, the boot control pin SEN must be driven high and IO2 must be driven low; subsequently the modem must be reset.

The memory must be connected to the pins of the dedicated serial peripheral interface (SPI), as shown in Figure 27. Any non-volatile memory with the standard command set and three bytes addressing is supported; is recommended.

The user must program the firmware into the external memory starting from address 0. Four bytes must be added at the end of the lowest 256-byte sector that can fit them, i.e. either the sector containing the last byte of the firmware or the next sector. These four bytes contain the checksum, the number of sectors used, and the magical numbers A5<sub>H</sub> and 5A<sub>H</sub>. The checksum must be computed over the entire binary.

Between the four metadata bytes and the firmware, zero-padding must be written.

This is illustrated in Table 12.



**Figure 27. Connecting an External SPI Memory to the Modem**

**Table 12. REQUIRED CONTENTS OF AN EXTERNAL BOOTABLE SPI MEMORY FOR A BINARY FIRMWARE FILE OF LENGTH N BYTES**

| Address                                              | Content                         |
|------------------------------------------------------|---------------------------------|
| 0                                                    | Firmware binary                 |
| ...                                                  |                                 |
| N                                                    |                                 |
| N + 1                                                | Zero padding, if required       |
| ...                                                  |                                 |
| $100_H \cdot S + FB_H$                               |                                 |
| $100_H \cdot S + FC_H$                               | Checksum                        |
| $100_H \cdot S + FD_H$                               | S, the number of sectors used   |
| $100_H \cdot S + FE_H$                               | Magical number: A5 <sub>H</sub> |
| $100_H \cdot S + FF_H$                               | Magical number: 5A <sub>H</sub> |
| Where S is the numbers of sectors used:              |                                 |
| $S = \left\lfloor \frac{N + 4}{100_H} \right\rfloor$ |                                 |

The tool PlcEepromGenerator.exe, provided by ON Semiconductor, may be used to convert a binary firmware file into a file that follows these requirements. The latter can be written directly in the external memory.

As an example, if the firmware binary size is 618 bytes, the first two 256-byte sector will be filled completely. The last 106 bytes of the firmware binary will be written to the third sector, followed by zero padding ( $256 - 106 - 4 = 146$

bytes), followed by four bytes: checksum, 03<sub>H</sub>, A5<sub>H</sub> and 5A<sub>H</sub>.

Once the boot loader has finished copying the firmware to the internal memory, the checksum is calculated and compared to the stored checksum. If both match, the processor is released from reset and the firmware starts executing. IO2 subsequently becomes available as a normal GPIO.

#### Firmware Upload over the Serial Communication Interface

During reset, the boot loader module in the modem can receive the firmware over the serial interface.

To enable this mode, the IO2 and the boot control pin SEN must be driven low; subsequently the modem must be reset. IO2 must remain low during the entire boot process; if driven high during boot the boot loader terminates immediately. To restart the boot loader, reset the modem.

As soon as the reset of the modem is released, the boot loader process starts. When it is ready to receive the firmware from the external microcontroller, the boot loader will send a 02<sub>H</sub> (STX) byte.

Upon receiving this byte the user must send the byte sequence specified in Table 13. The sequence contains a checksum to verify correctness of the received binary image. The CRC must be calculated over the firmware binary only (excluding the magical number and the size). The program crc.exe, provided by ON Semiconductor, can be used for this calculation.

**Table 13. BYTE SEQUENCE to be transmitted by the application microcontroller during firmware upload**

| Value               | Description                                                                                                    |
|---------------------|----------------------------------------------------------------------------------------------------------------|
| [ CE <sub>H</sub> ] | Should only be sent to restart the boot loader process, in response to a NAK character received from the modem |
| AA <sub>H</sub>     | Magical number                                                                                                 |
| Size (LSB)          | The size of the entire firmware binary, including the four bytes for the CRC at the end                        |
| Size (MSB)          |                                                                                                                |
| Binary, first byte  | Contents of the firmware binary                                                                                |
| ...                 |                                                                                                                |
| Binary, last byte   |                                                                                                                |
| CRC (LSB)           | CRC, as calculated on the binary only                                                                          |
| CRC (MSB)           |                                                                                                                |

Data transmission must start only after receiving the STX byte. In addition, the first byte must be sent within 350 ms. If these timing constraints are not satisfied the boot loader will send a 15<sub>H</sub> (NAK) character and will reject any data received until the application microprocessor stops sending bytes for at least 100 ms. The pause will restart the boot loader, and a new STX character will be sent to the application microcontroller to indicate this.

Once transmission has started, the maximal delay between consecutive bytes is 20 ms. If this timing

constraints is not met, or if the checksum is incorrect, the boot loader will send a 15<sub>H</sub> (NAK) character. This error also occurs when the user attempts to upload a binary exceeding the maximal size of 7F00<sub>H</sub> (32512) bytes. When the application microcontroller receives this NAK, it should transmit a CE<sub>H</sub> (mnemonic for “clear error”) byte. This informs the boot loader that the application microcontroller understood the problem. Following the CE<sub>H</sub> byte, the microcontroller may restart.

The timing constraints are illustrated in Figure 3.

## Application Information

For a system-level overview of power line communication, refer to [4]. For more information on how to design with the NCN49597 modem, refer to the design manual available from your sales representative [1]. This section gives a few hints.

### Supplies and Decoupling

For optimal stability and noise rejection, all power supplies must be decoupled as physically close to the device as possible.

The analogue and digital blocks are powered through independent power supply pins (VDDA resp. VDD); the nominal supply voltage is 3.3 V. On both pins, decoupling must be provided with at least a ceramic capacitor of 100 nF between the pin and the corresponding ground (VSSA resp. VSS). The connection path of these capacitors on the printed circuit board (PCB) should be kept as short as possible in order to minimize the parasitic inductance.

It is recommended to tie both analogue and digital ground pins to a single, uninterrupted ground plane.

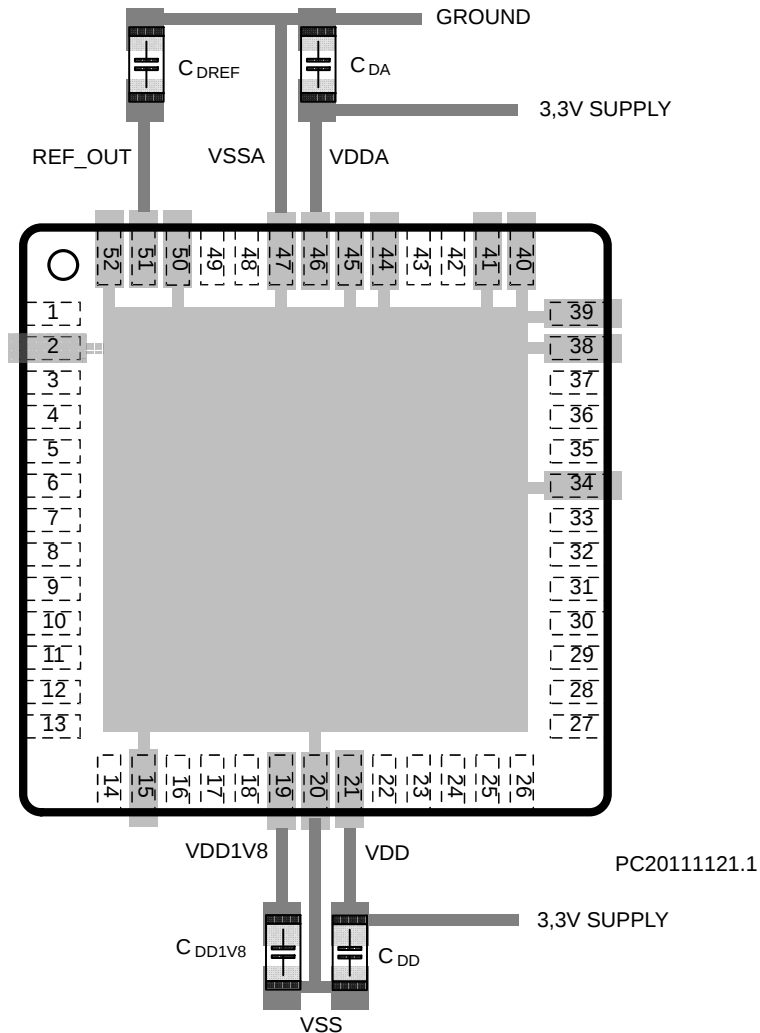


Figure 28. Recommended Layout of the Placement of Decoupling Capacitors (bottom ground plane not shown)

### Internal Voltage Reference

REF\_OUT is the analog output pin which provides the voltage reference used by the A/D converter. This pin must be decoupled to the analog ground by a 1  $\mu$ F ceramic capacitance  $C_{DREF}$ . The connection path of this capacitor to the VSSA on the PCB should be kept as short as possible in order to minimize the serial inductance.

### Internal Voltage Regulator

An internal linear regulator provides the 1.8 V core voltage for the microcontroller. This voltage is connected to pin VDD1V8. A ceramic decoupling capacitor of 1  $\mu$ F to ground must be connected as close as possible to this pin (Figure 28).

The internal regulator should not be used to power other components.

## References

In this document references are made to:

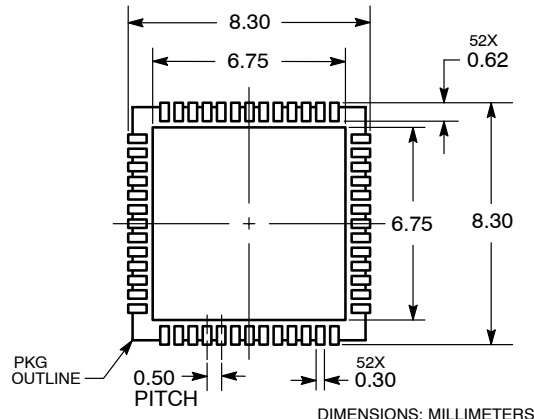
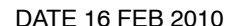
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**Table 14. ORDERING INFORMATION**

| Part Number  | Temperature Range | Package Type     | Shipping <sup>†</sup> |
|--------------|-------------------|------------------|-----------------------|
| NCN49597MNG  | -40°C – 125°C     | QFN-52 (Pb-Free) | Tube                  |
| NCN49597MNRG | -40°C – 125°C     | QFN-52 (Pb-Free) | Tape & Reel           |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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